

## CapSense® Express™ Button Capacitive Controllers

### Features

- 10/8/6/4 capacitive button input
  - Robust sensing algorithm
  - High sensitivity, low noise
  - Immunity to RF and AC noise
  - Low radiated EMC noise
  - Supports wide range of input capacitance, sensor shapes, and sizes
- Target applications
  - Printers
  - Cellular handsets
  - LCD monitors
  - Portable DVD players
- Low operating current
  - Active current: continuous sensor scan: 1.5 mA
  - Deep sleep current: 4  $\mu$ A
- Industry's best configurability
  - Custom sensor tuning, one optional capacitor
  - Output supports strong drive for LED
  - Output state can be controlled through I<sup>2</sup>C or directly from CapSense® input state
  - Run time reconfigurable over I<sup>2</sup>C
- Advanced features
  - All GPIOs support LED dimming with configurable delay option in CY8C20110
  - Interrupt outputs
  - User defined inputs
  - Wake on interrupt input
  - Sleep control pin
  - Nonvolatile storage of custom settings
  - Easy integration into existing products – configure output to match system
  - No external components required
  - World-class free configuration tool
- Wide range of operating voltages
  - 2.4 V to 2.9 V
  - 3.10 V to 3.6 V
  - 4.75 V to 5.25 V
- I<sup>2</sup>C communication
  - Supported from 1.8 V
  - Internal pull-up resistor support option
  - Data rate up to 400 kbps
  - Configurable I<sup>2</sup>C addressing
- Industrial temperature range: –40 °C to +85 °C
- Available in 16-pin QFN, 8-pin, and 16-pin SOIC packages

### Overview

These CapSense Express™ controllers support four to ten capacitive sensing (CapSense) buttons. The device functionality is configured through an I<sup>2</sup>C port and can be stored in onboard nonvolatile memory for automatic loading at power-on. The CY8C20110 is optimized for dimming LEDs in 15 selectable duty cycles for back light applications. The device can be configured to have up to 10 GPIOs connected to the PWM output. The PWM duty cycle is programmable for variable LED intensities.

The four key blocks that make up these devices are: a robust capacitive sensing core with high immunity against radiated and conductive noise, control registers with nonvolatile storage, configurable outputs, and I<sup>2</sup>C communications. The user can configure registers with parameters needed to adjust the operation and sensitivity of the CapSense buttons and outputs and permanently store the settings. The standard I<sup>2</sup>C serial communication interface enables the host to configure the device and read sensor information in real time. The I<sup>2</sup>C address is fully configurable without any external hardware strapping.

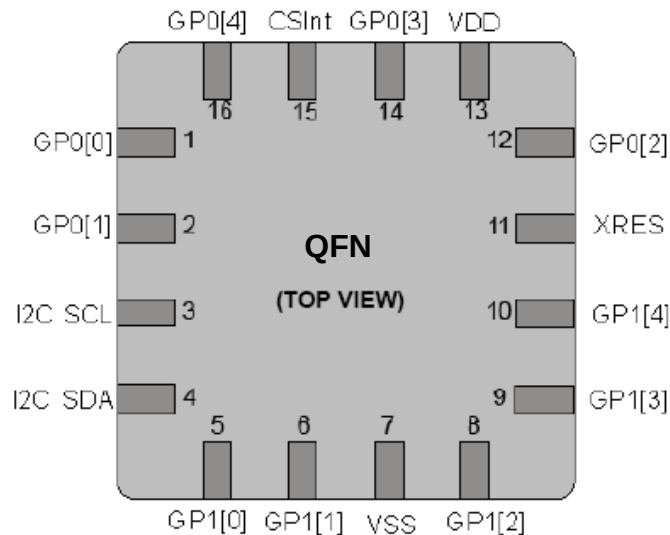
**Errata:** For information on silicon errata, see "Errata" on page 40. Details include trigger conditions, devices affected, and proposed workaround.

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## Pinouts -16-Pin QFN

Figure 1. 16-pin QFN (3 × 3 × 0.6 mm) (no e-pad) Pinout <sup>[1]</sup>



## Pin Definitions

16-pin QFN (no e-pad) <sup>[1, 2]</sup>

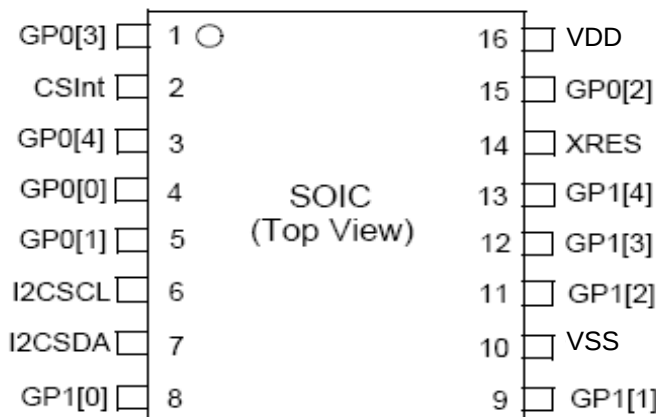
| Pin No. | Pin Name              | Description                                                                                                                           |
|---------|-----------------------|---------------------------------------------------------------------------------------------------------------------------------------|
| 1       | GP0[0]                | Configurable as CapSense or GPIO                                                                                                      |
| 2       | GP0[1]                | Configurable as CapSense or GPIO                                                                                                      |
| 3       | I <sup>2</sup> C SCL  | I <sup>2</sup> C clock                                                                                                                |
| 4       | I <sup>2</sup> C SDA  | I <sup>2</sup> C data                                                                                                                 |
| 5       | GP1[0]                | Configurable as CapSense or GPIO                                                                                                      |
| 6       | GP1[1] <sup>[3]</sup> | Configurable as CapSense or GPIO                                                                                                      |
| 7       | VSS                   | Ground connection                                                                                                                     |
| 8       | GP1[2] <sup>[3]</sup> | Configurable as CapSense or GPIO                                                                                                      |
| 9       | GP1[3]                | Configurable as CapSense or GPIO                                                                                                      |
| 10      | GP1[4]                | Configurable as CapSense or GPIO                                                                                                      |
| 11      | XRES                  | Active high external reset with internal pull-down                                                                                    |
| 12      | GP0[2]                | Configurable as CapSense or GPIO                                                                                                      |
| 13      | VDD                   | Supply voltage                                                                                                                        |
| 14      | GP0[3]                | Configurable as CapSense or GPIO                                                                                                      |
| 15      | CSInt                 | Integrating capacitor Input. The external capacitance is required only if 5:1 SNR cannot be achieved. Typical range is 1 nF to 4.7 nF |
| 16      | GP0[4]                | Configurable as CapSense or GPIO                                                                                                      |

### Notes

1. CY8C20110 (10 Buttons) / CY8C20180 (8 Buttons) / CY8C20160 (6 Buttons) / CY8C20140 (4 Buttons)
2. 8/6/4 available configurable IOs can be configured to any of the 10 IOs of the package. After any of the 8/6/4 IOs are chosen, the remaining 2/4/6 IOs of the package are not available for any functionality.
3. Avoid using GP1[1] and GP1[2] for driving LEDs. These two pins have special functions during power-up which is used at factory. LEDs connected to these two pins blink during the power-up of the device.

## Pinouts - 16-Pin SOIC

Figure 2. 16-pin SOIC (150 Mils) Pinout <sup>[4]</sup>



## Pin Definitions

16-pin SOIC <sup>[4, 5]</sup>

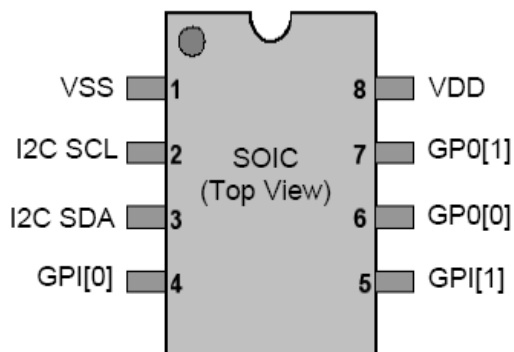
| Pin No. | Name                  | Description                                                                                                                            |
|---------|-----------------------|----------------------------------------------------------------------------------------------------------------------------------------|
| 1       | GP0[3]                | Configurable as CapSense or GPIO                                                                                                       |
| 2       | CSInt                 | Integrating capacitor input. The external capacitance is required only if 5:1 SNR cannot be achieved. Typical range is 1 nF to 4.7 nF. |
| 3       | GP0[4]                | Configurable as CapSense or GPIO                                                                                                       |
| 4       | GP0[0]                | Configurable as CapSense or GPIO                                                                                                       |
| 5       | GP0[1]                | Configurable as CapSense or GPIO                                                                                                       |
| 6       | I <sup>2</sup> C SCL  | I <sup>2</sup> C clock                                                                                                                 |
| 7       | I <sup>2</sup> C SDA  | I <sup>2</sup> C data                                                                                                                  |
| 8       | GP1[0]                | Configurable as CapSense or GPIO                                                                                                       |
| 9       | GP1[1] <sup>[6]</sup> | Configurable as CapSense or GPIO                                                                                                       |
| 10      | VSS                   | Ground connection                                                                                                                      |
| 11      | GP1[2] <sup>[6]</sup> | Configurable as CapSense or GPIO                                                                                                       |
| 12      | GP1[3]                | Configurable as CapSense or GPIO                                                                                                       |
| 13      | GP1[4]                | Configurable as CapSense or GPIO                                                                                                       |
| 14      | XRES                  | Active high external reset with internal pull-down                                                                                     |
| 15      | GP0[2]                | Configurable as CapSense or GPIO                                                                                                       |
| 16      | VDD                   | Supply voltage                                                                                                                         |

### Notes

- CY8C20110 (10 Buttons) / CY8C20180 (8 Buttons) / CY8C20160 (6 Buttons) / CY8C20140 (4 Buttons)
- 8/6/4 available configurable IOs can be configured to any of the 10 IOs of the package. After any of the 8/6/4 IOs are chosen, the remaining 2/4/6 IOs of the package are not available for any functionality.
- Avoid using GP1[1] and GP1[2] for driving LEDs. These two pins have special functions during power-up which is used at factory. LEDs connected to these two pins blink during the power-up of the device.

## Pinouts - 8-pin SOIC

**Figure 3. 8-pin SOIC (150 Mils) pinout  
CY8C20142 (4 Button)**



## Pin Definitions

8-pin SOIC

CY8C20142 (4 Button)

| Pin No. | Name                  | Description                      |
|---------|-----------------------|----------------------------------|
| 1       | VSS                   | Ground                           |
| 2       | I <sup>2</sup> C SCL  | I <sup>2</sup> C Clock           |
| 3       | I <sup>2</sup> C SDA  | I <sup>2</sup> C Data            |
| 4       | GP1[0] <sup>[7]</sup> | Configurable as CapSense or GPIO |
| 5       | GP1[1] <sup>[7]</sup> | Configurable as CapSense or GPIO |
| 6       | GP0[0]                | Configurable as CapSense or GPIO |
| 7       | GP0[1]                | Configurable as CapSense or GPIO |
| 8       | VDD                   | Supply voltage                   |

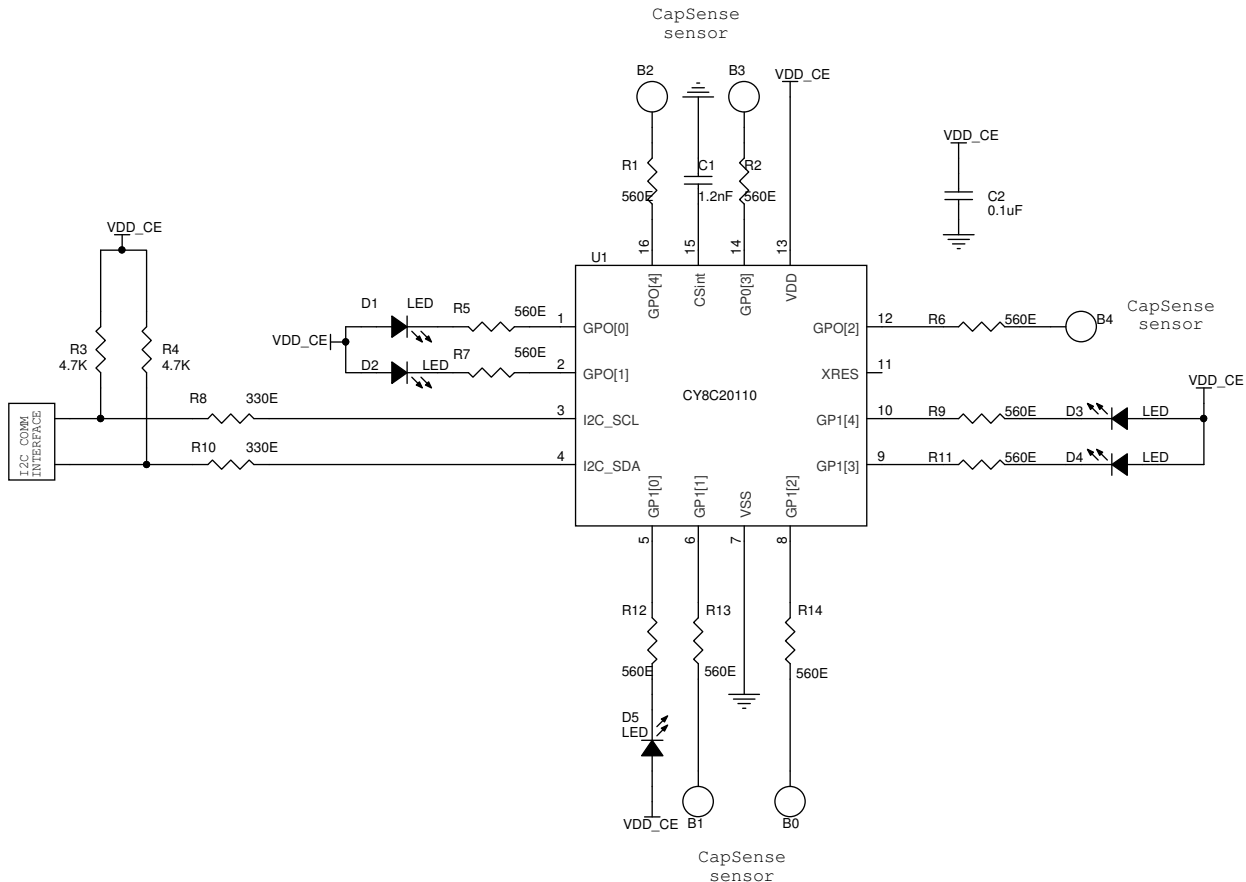
**Important Note** For information on the preferred dimensions for mounting QFN packages, see the "Application Notes for Surface Mount Assembly of Amkor's MicroLeadFrame (MLF) Packages" available at <http://www.amkor.com>.

### Note

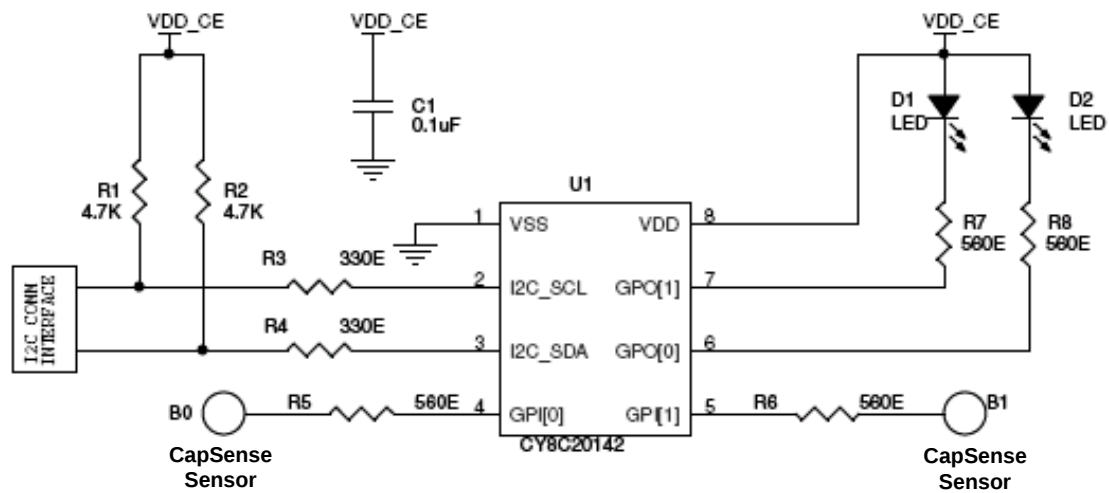
7. Avoid using GP1[0] and GP1[1] for driving LED. These two pins have special functions during power up which is used at factory. LEDs connected to these two pins will blink during power up of the device.

## Typical Circuits

**Figure 4. Circuit 1 – Five Buttons and Five LEDs with I<sup>2</sup>C Interface**



**Figure 5. Circuit 2 – Two Buttons and Two LEDs with I<sup>2</sup>C Interface**



## Typical Circuits (continued)

Figure 6. Circuit 3 – Compatibility with 1.8 V I<sup>2</sup>C Signaling [8, 9]

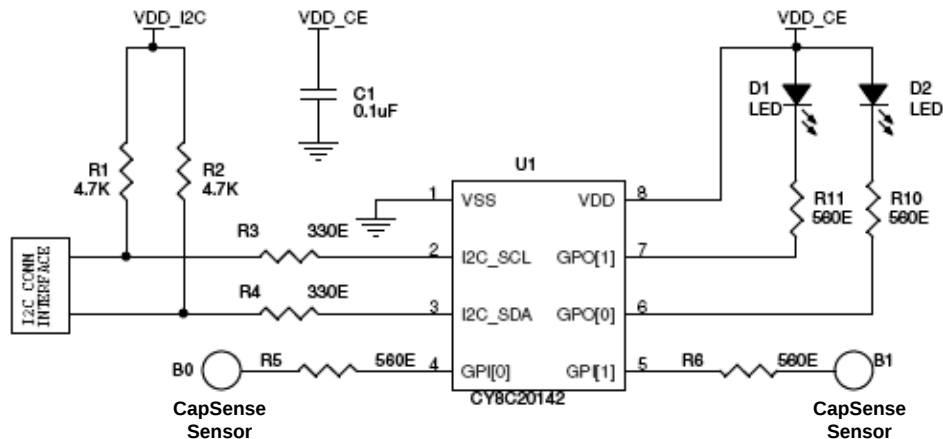
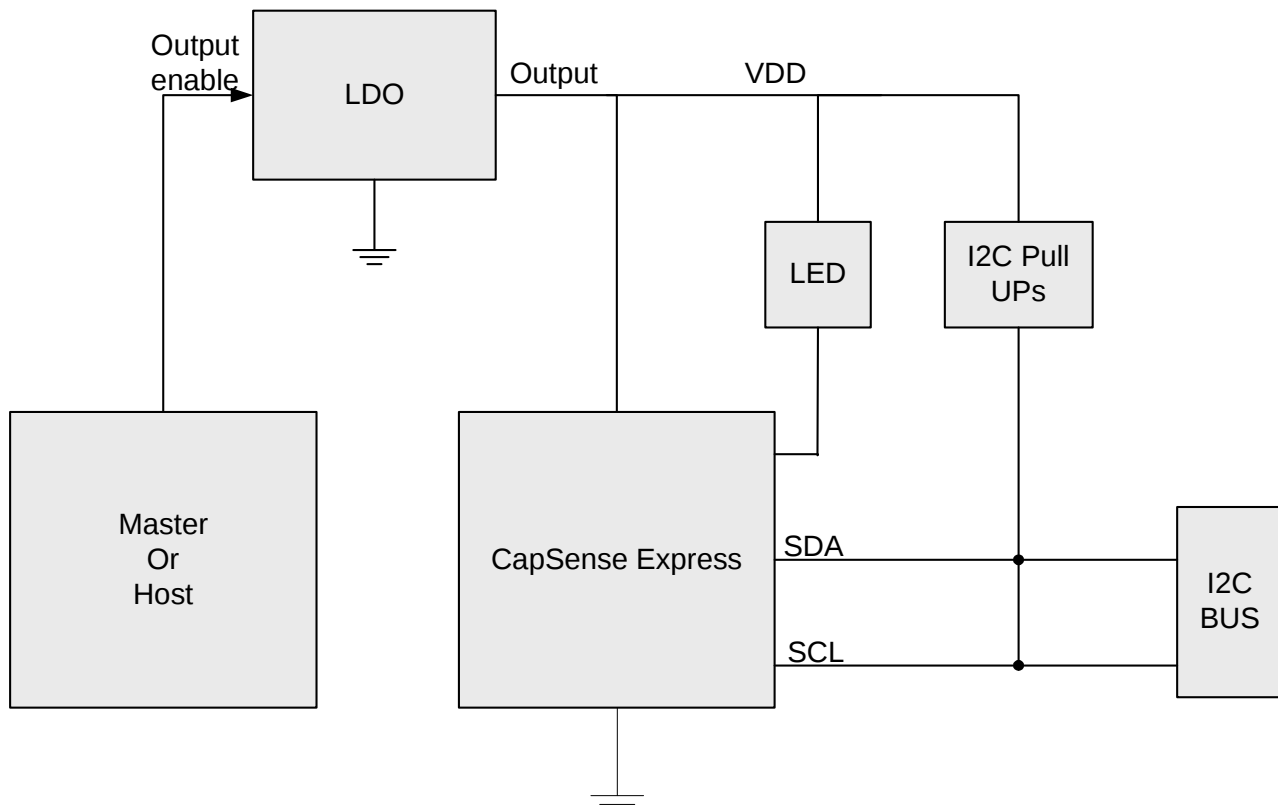


Figure 7. Circuit 4 – Powering Down CapSense Express Device for Low Power Requirements [10]



### Notes

8.  $1.8\text{ V} \leq \text{VDD\_I2C} \leq \text{VDD\_CE}$  and  $2.4\text{ V} \leq \text{VDD\_CE} \leq 5.25\text{ V}$ .
9. The I2C drive mode of the CapSense device should be configured properly before using in an I2C environment with external pull-ups. Please refer to I2C\_ADDR\_DM register and its factory setting.
10. For low power requirements, if V<sub>DD</sub> is to be turned off, this concept can be used. The requirement is that the V<sub>DD</sub>s of CapSense Express, I<sup>2</sup>C pull-ups, and LEDs should be from the same source such that turning off the V<sub>DD</sub> ensures that no signal is applied to the device while it is unpowered. The I<sup>2</sup>C signals should not be driven high by the master in this situation. If a port pin or group of port pins of the master can cater to the power supply requirements of the circuit, the LDO can be avoided.

## I<sup>2</sup>C Interface

The CapSense Express devices support the industry-standard I<sup>2</sup>C protocol, which can be used for:

- Configuring the device
- Reading the status and data registers of the device
- Controlling device operation
- Executing commands

The I<sup>2</sup>C address can be modified during configuration.

### I<sup>2</sup>C Device Addressing

The device uses a seven-bit addressing protocol. The I<sup>2</sup>C data transfer is always initiated by the master sending a one-byte address: the first seven bits contain the address and the LSB indicates the data transfer direction. Zero in the LSB bit indicates the write transaction from master and one indicates the read transfer by the master. The following table shows examples for different I<sup>2</sup>C addresses.

**Table 1. I<sup>2</sup>C Address Examples**

| 7-bit Slave Address | D7 | D6 | D5 | D4 | D3 | D2 | D1 | D0   | 8-bit Slave Address |
|---------------------|----|----|----|----|----|----|----|------|---------------------|
| 1                   | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 0(W) | 02                  |
| 1                   | 0  | 0  | 0  | 0  | 0  | 0  | 1  | 1(R) | 03                  |
| 75                  | 1  | 0  | 0  | 1  | 0  | 1  | 1  | 0(W) | 96                  |
| 75                  | 1  | 0  | 0  | 1  | 0  | 1  | 1  | 1(W) | 97                  |

### I<sup>2</sup>C Clock Stretching

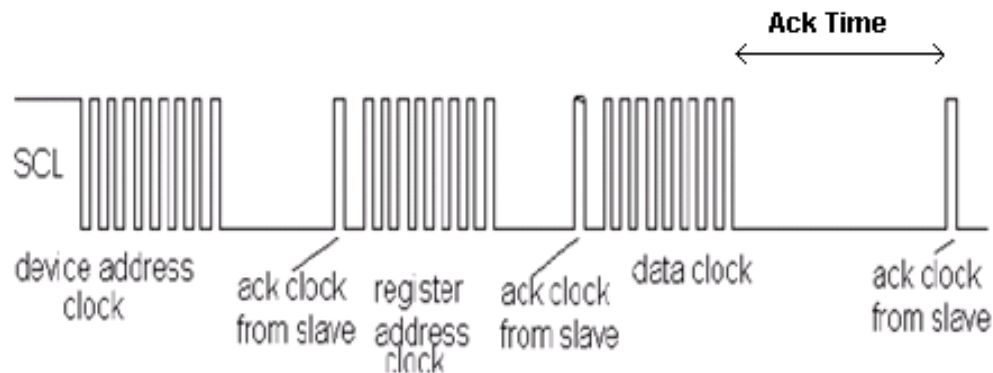
'Clock stretching' or 'bus stalling' in I<sup>2</sup>C communication protocol is a state in which the slave holds the SCL line low to indicate that it is busy. In this condition, the master is expected to wait until the SCL is released by the slave.

When an I<sup>2</sup>C master communicates with the CapSense Express device, the CapSense Express stalls the I<sup>2</sup>C bus after the reception of each byte (that is, just before the ACK/NAK bit) until processing of the byte is complete and critical internal functions are executed. Use a fully I<sup>2</sup>C compliant master to communicate with the CapSense Express device.

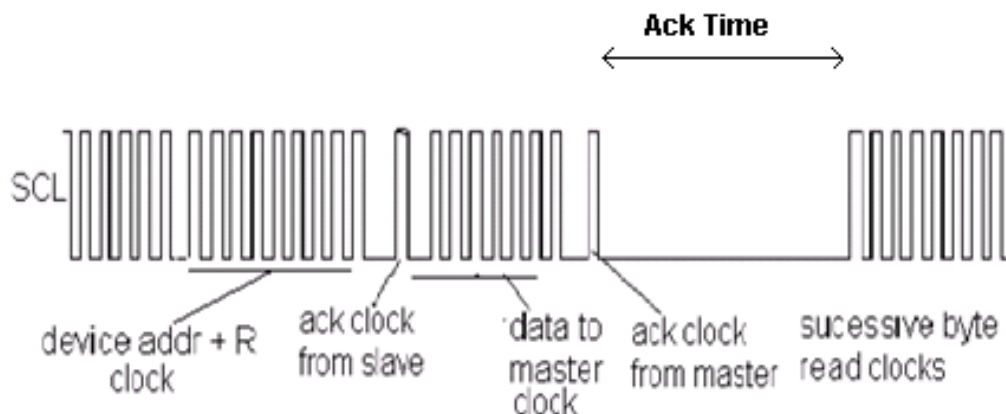
If the I<sup>2</sup>C master does not support clock stretching (a bit banded software I<sup>2</sup>C Master), the master must wait for a specific amount of time (as specified in [Format for Register Write and Read on page 9](#)) for each register write and read operation before the next bit is transmitted. The I<sup>2</sup>C master must check the SCL status (it should be high) before the I<sup>2</sup>C master initiates any data transfer with CapSense Express. If the master fails to do so and continues to communicate, the communication is erroneous.

The following diagrams represent the ACK time delays shown in [Format for Register Write and Read on page 9](#) for write and read.

**Figure 8. Write ACK Time Representation** <sup>[11]</sup>



**Figure 9. Read ACK Time Representation** <sup>[12]</sup>



### Format for Register Write and Read

#### Register write format

|       |                |   |          |   |      |   |      |   |       |      |   |      |
|-------|----------------|---|----------|---|------|---|------|---|-------|------|---|------|
| Start | Slave Addr + W | A | Reg Addr | A | Data | A | Data | A | ..... | Data | A | Stop |
|-------|----------------|---|----------|---|------|---|------|---|-------|------|---|------|

#### Register read format

|       |                |   |          |   |      |   |       |      |   |      |  |  |
|-------|----------------|---|----------|---|------|---|-------|------|---|------|--|--|
| Start | Slave Addr + W | A | Reg Addr | A | Stop |   |       |      |   |      |  |  |
| Start | Slave Addr + R | A | Data     | A | Data | A | ..... | Data | N | Stop |  |  |

#### Legends:

|        |         |
|--------|---------|
| Master | A – ACK |
| Slave  | N – NAK |

#### Notes

11. Time to process the received data.
12. Time taken for the device to send next byte.

## Operating Modes of I<sup>2</sup>C Commands

### Normal Mode

In normal mode of operation, the acknowledgment time<sup>[13]</sup> is optimized. The timings remain approximately the same for different configurations of the slave. To reduce the acknowledgment times in normal mode, the registers 0x06–0x09, 0x0C, 0x0D, 0x10–0x17, 0x50, 0x51, 0x57–0x60, 0x7E are given only read access. Write to these registers can be done only in setup mode.

### Setup Mode

All registers have read and write access (except those which are read only) in this mode. The acknowledgment times<sup>[14]</sup> are longer compared to normal mode. When CapSense scanning is disabled (command code 0x0A in command register 0xA0), the acknowledgment times can be improved to values similar to the normal mode of operation.

## Device Operation Modes

CapSense Express devices are configured to operate in any of the following three modes to meet different power consumption requirements:

- Active Mode
- Periodic Sleep Mode
- Deep Sleep Mode

### Active Mode

In the Active mode, all the device blocks including the CapSense subsystem are powered. Typical active current consumption of the device across the operating voltage range is 1.5 mA.

### Periodic Sleep Mode

Sleep mode provides an intermediate power operation mode. It is enabled by configuring the corresponding device registers (0x7E, 0x7F). The device goes into sleep after there is no event for stay awake counter (Reg 0x80) number of sleep intervals. The device wakes up on sleep interval and scans the capacitive sensors before going back to sleep again. If any sensor is active, then the device wakes up. The device can also wake up from Sleep mode with a GPIO interrupt. The sleep interval is configured through registers. The following sleep intervals are supported in CapSense Express:

- 1.95 ms (512 Hz)
- 15.6 ms (64 Hz)
- 125 ms (8 Hz)
- 1 s (1 Hz)

The sleep interval should be 8 Hz or 1 Hz when using save to flash command. The configuration sequence should be:

1. Write configuration data to registers with sleep interval being 8 Hz or 1 Hz
2. Save the settings to flash
3. Change the sleep interval as per design.

### Deep Sleep Mode

Deep Sleep mode provides the lowest power consumption because there is no operation running. All CapSense scanning is disabled during this mode. In this mode, the device wakes up only using an external GPIO interrupt. A sleep timer interrupt cannot wake up a device from deep sleep mode. This is treated as a continuous sleep mode without periodic wakeups. Refer to the application note “[CapSense Express Power and Sleep Considerations](#)” - AN44209 for details on different sleep modes. To get the lowest power during this mode the sleep timer frequency should be set to 1 Hz.

## Sleep Control Pin

The devices require a dedicated sleep control pin to enable reliable I<sup>2</sup>C communication in case any sleep mode is enabled. This is achieved by pulling the sleep control pin low to wake up the device and start I<sup>2</sup>C communication. The sleep control pin can be configured on any GPIO.

## Interrupt Pin to Master

To inform the master of any button press a GPIO can be configured as interrupt output and all CapSense buttons can be connected to this GPIO with an OR logic operator. This can be configured using the software tool.

## LED Dimming

To change the brightness and intensity of the LEDs, the host master (MCU, MPU, DSP, and so on) must send I<sup>2</sup>C commands and program the PWM registers to enable output pins, set duty cycle, and mode configuration. The single PWM source is connected to all GPIO pins and has a common user defined duty cycle. Each PWM enabled pin has two possible outputs: PWM and 0/1 (depending on the configuration). Four different modes of LED<sup>[15]</sup> dimming are possible, as shown in [LED Dimming Mode 1: Change Intensity on ON/OFF Button Status on page 11](#) to [LED Dimming Mode 4: Toggle Intensity on ON/OFF or OFF/ON Button Transitions on page 12](#). The operation mode and duty cycle of the PWM enabled pins is common. This means that one pin cannot behave as in Mode 1 and another pin as in Mode 2.

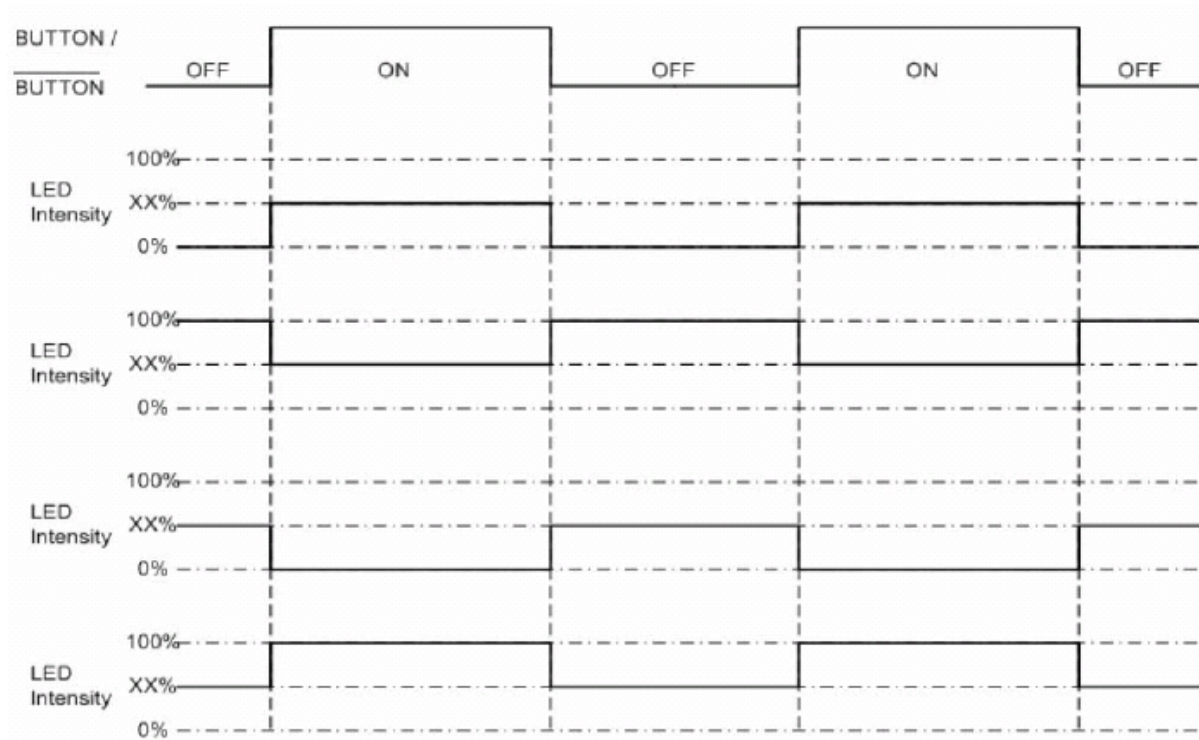
### Notes

**13. Errata:** The worst case Acknowledgment time for all critical registers is 140  $\mu$ s. For more information, see “[Errata](#)” on page 40.

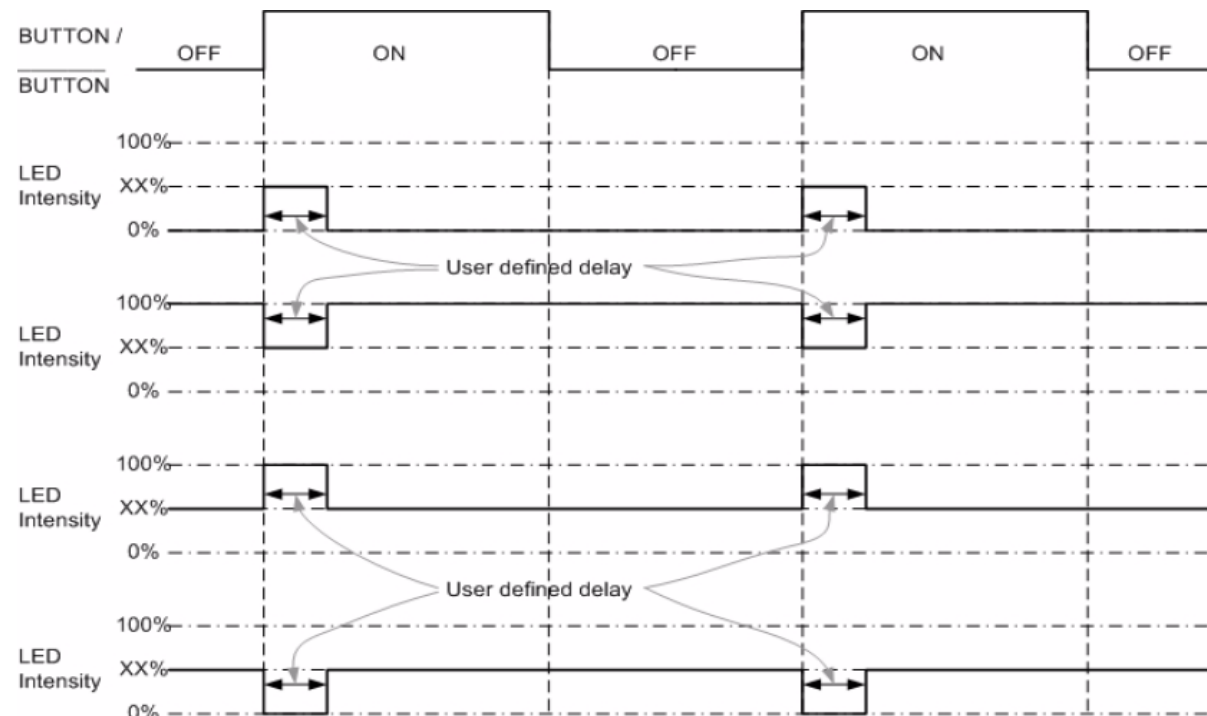
**14. Errata:** The CY8C20110 device acknowledges to host within 100  $\mu$ s, but is not accessible for any other operation until configuration is successfully stored into flash memory and the device is ready to execute the next command. For more information, see “[Errata](#)” on page 40.

**15. Errata:** Applicable only for CY8C20110 device. For more information, see “[Errata](#)” on page 40.

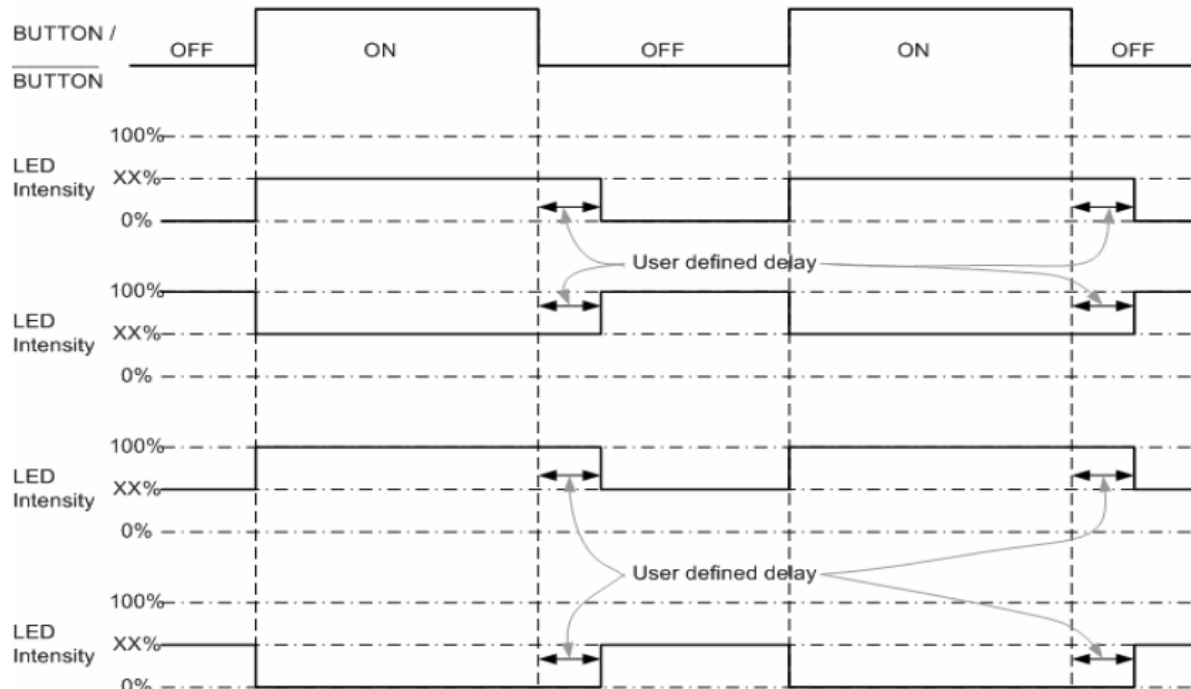
### LED Dimming Mode 1: Change Intensity on ON/OFF Button Status



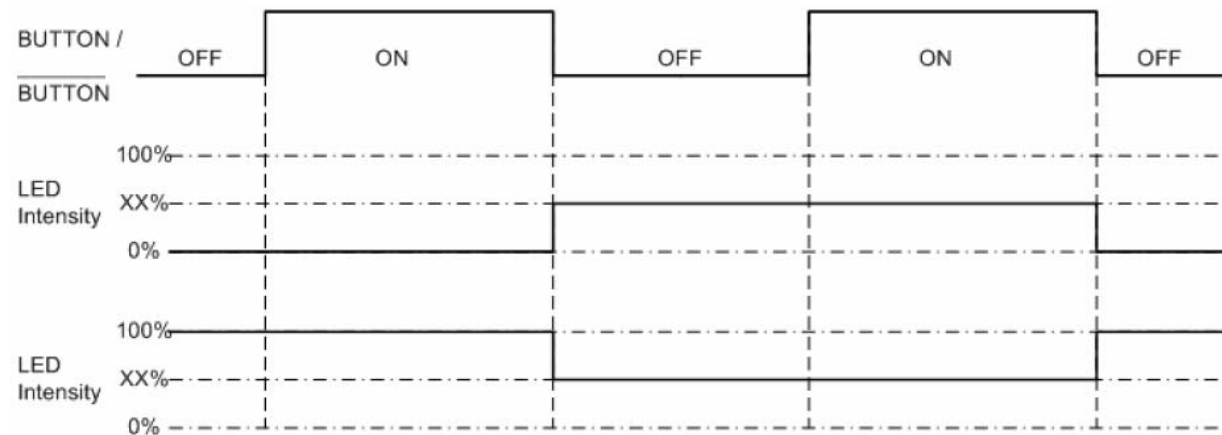
### LED Dimming Mode 2: Flash Intensity on ON Button Status



### LED Dimming Mode 3: Hold Intensity After ON/OFF Button Transition



### LED Dimming Mode 4: Toggle Intensity on ON/OFF or OFF/ON Button Transitions



**Note** LED DIMMING is available only in CY8C20110.

## Registers

### Register Map

| Name                        | Register Address (in Hex) | Access | Writable Only in SETUP Mode <sup>[16]</sup> | Factory Default Values of Registers (in Hex) | I2C Max ACK Time in Normal Mode (ms) <sup>[17]</sup> | I2C Max ACK Time in Setup Mode (ms) <sup>[17]</sup> |
|-----------------------------|---------------------------|--------|---------------------------------------------|----------------------------------------------|------------------------------------------------------|-----------------------------------------------------|
| INPUT_PORT0                 | 00                        | R      | –                                           | 00                                           | 0.1                                                  | –                                                   |
| INPUT_PORT1                 | 01                        | R      | –                                           | 00                                           | 0.1                                                  | –                                                   |
| STATUS_POR0                 | 02                        | R      | –                                           | 00                                           | 0.1                                                  | –                                                   |
| STATUS_POR1                 | 03                        | R      | –                                           | 00                                           | 0.1                                                  | –                                                   |
| OUTPUT_PORT0                | 04                        | W      | –                                           | 00                                           | 0.1                                                  | –                                                   |
| OUTPUT_PORT1                | 05                        | W      | –                                           | 00                                           | 0.1                                                  | –                                                   |
| CS_ENABLE0                  | 06                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| CS_ENABLE                   | 07                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| GPIO_ENABLE0                | 08                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| GPIO_ENABLE1                | 09                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| INVERSION_MASK0             | 0A                        | RW     | –                                           | 00                                           | 0.11                                                 | –                                                   |
| INVERSION_MASK1             | 0B                        | RW     | –                                           | 00                                           | 0.11                                                 | –                                                   |
| INT_MASK0                   | 0C                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| INT_MASK1                   | 0D                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| STATUS_HOLD_MSK0            | 0E                        | RW     | –                                           | 03/1F <sup>[18]</sup>                        | 0.11                                                 | –                                                   |
| STATUS_HOLD_MSK1            | 0F                        | RW     | –                                           | 03/1F <sup>[18]</sup>                        | 0.11                                                 | –                                                   |
| DM_PULL_UP0                 | 10                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_STRONG0                  | 11                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_HIGHZ0                   | 12                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_OD_LOW0                  | 13                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_PULL_UP1                 | 14                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_STRONG1                  | 15                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_HIGHZ1                   | 16                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| DM_OD_LOW1                  | 17                        | RW     | YES                                         | 00                                           | –                                                    | 11                                                  |
| PWM_ENABLE0 <sup>[19]</sup> | 18                        | RW     | –                                           | 00                                           | 0.1                                                  | –                                                   |
| PWM_ENABLE1 <sup>[19]</sup> | 19                        | RW     | –                                           | 00                                           | 0.1                                                  | –                                                   |
| PWM_MODE_DC <sup>[19]</sup> | 1A                        | RW     | –                                           | 00                                           | 0.1                                                  | –                                                   |
| PWM_DELAY <sup>[19]</sup>   | 1B                        | RW     | –                                           | 00                                           | 0.1                                                  | –                                                   |
| OP_SEL_00                   | 1C                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_00                | 1D                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_00                | 1E                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_00                | 1F                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_00                | 20                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_01                   | 21                        | RW     | –]                                          | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_01                | 22                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_01                | 23                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_01                | 24                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_01                | 25                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_02                   | 26                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |

#### Notes

16. These registers are writable only after entering into setup mode. All the other registers available for read and write in Normal as well as in Setup mode.  
17. The "I2C Max ACK Time" values mentioned in this table are for 3.3-V and 5-V operation; the timing values for 2.7-V operation are 4x the values provided in this table. Refer to [Operating Voltages on page 21](#).  
18. The factory defaults of Reg 0x0E and 0x0F is 0x03 for 20142 device and 0x1F for 20140/60/80/10 devices.  
19. **Errata:** These registers are available only in CY8C20110. For more information, see ["Errata" on page 40](#).

**Register Map** (continued)

| Name          | Register Address (in Hex) | Access | Writable Only in SETUP Mode <sup>[16]</sup> | Factory Default Values of Registers (in Hex) | I2C Max ACK Time in Normal Mode (ms) <sup>[17]</sup> | I2C Max ACK Time in Setup Mode (ms) <sup>[17]</sup> |
|---------------|---------------------------|--------|---------------------------------------------|----------------------------------------------|------------------------------------------------------|-----------------------------------------------------|
| OPR1_PRT0_02  | 27                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_02  | 28                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_02  | 29                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_02  | 2A                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_03     | 2B                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_03  | 2C                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_03  | 2D                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_03  | 2E                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_03  | 2F                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_04     | 30                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_04  | 31                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_04  | 32                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_04  | 33                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_04  | 34                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_10     | 35                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_10  | 36                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_10  | 37                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_10  | 38                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_10  | 39                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_11     | 3A                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_11  | 3B                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_11  | 3C                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_11  | 3D                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_11  | 3E                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_12     | 3F                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_12  | 40                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_12  | 41                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_12  | 42                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_12  | 43                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_13     | 44                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_13  | 45                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_13  | 46                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_13  | 47                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_13  | 48                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OP_SEL_14     | 49                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT0_14  | 4A                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR1_PRT1_14  | 4B                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT0_14  | 4C                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| OPR2_PRT1_14  | 4D                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_NOISE_TH   | 4E                        | RW     | –                                           | 28                                           | 0.11                                                 | 11                                                  |
| CS_BL_UPD_TH  | 4F                        | RW     | –                                           | 64                                           | 0.11                                                 | 11                                                  |
| CS_SETL_TIME  | 50                        | RW     | YES                                         | A0                                           | –                                                    | 35                                                  |
| CS_OTH_SET    | 51                        | RW     | YES                                         | 00                                           | –                                                    | 35                                                  |
| CS_HYSTERISIS | 52                        | RW     | –                                           | 0A                                           | 0.11                                                 | 11                                                  |
| CS_DEBOUNCE   | 53                        | RW     | –                                           | 03                                           | 0.11                                                 | 11                                                  |

**Register Map** (continued)

| Name                            | Register Address (in Hex) | Access | Writable Only in SETUP Mode <sup>[16]</sup> | Factory Default Values of Registers (in Hex) | I2C Max ACK Time in Normal Mode (ms) <sup>[17]</sup> | I2C Max ACK Time in Setup Mode (ms) <sup>[17]</sup> |
|---------------------------------|---------------------------|--------|---------------------------------------------|----------------------------------------------|------------------------------------------------------|-----------------------------------------------------|
| CS_NEG_NOISE_TH                 | 54                        | RW     | –                                           | 14                                           | 0.11                                                 | 11                                                  |
| CS_LOW_BL_RST                   | 55                        | RW     | –                                           | 14                                           | 0.11                                                 | 11                                                  |
| CS_FILTERING <sup>[20,21]</sup> | 56                        | RW     | –                                           | 20                                           | 0.11                                                 | 11                                                  |
| CS_SCAN_POS_00                  | 57                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_01                  | 58                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_02                  | 59                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_03                  | 5A                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_04                  | 5B                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_10                  | 5C                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_11                  | 5D                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_12                  | 5E                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_13                  | 5F                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_SCAN_POS_14                  | 60                        | RW     | YES                                         | FF                                           | –                                                    | 11                                                  |
| CS_FINGER_TH_00                 | 61                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_01                 | 62                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_02                 | 63                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_03                 | 64                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_04                 | 65                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_10                 | 66                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_11                 | 67                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_12                 | 68                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_13                 | 69                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_FINGER_TH_14                 | 6A                        | RW     | –                                           | 64                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_00                      | 6B                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_01                      | 6C                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_02                      | 6D                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_03                      | 6E                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_04                      | 6F                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_10                      | 70                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_11                      | 71                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_12                      | 72                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_13                      | 73                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
| CS_IDAC_14                      | 74                        | RW     | –                                           | 0A                                           | 0.14                                                 | 11                                                  |
|                                 | 75 <sup>[22]</sup>        |        |                                             |                                              |                                                      |                                                     |
|                                 | 76 <sup>[22]</sup>        |        |                                             |                                              |                                                      |                                                     |
|                                 | 77 <sup>[22]</sup>        |        |                                             |                                              |                                                      |                                                     |
|                                 | 78 <sup>[22]</sup>        |        |                                             |                                              |                                                      |                                                     |
| I2C_ADDR_LOCK                   | 79                        | RW     | –                                           | 01                                           | 0.11                                                 | 11                                                  |
| DEVICE_ID                       | 7A                        | R      | –                                           | 42/40/60/80/10 <sup>[23]</sup>               | 0.11                                                 | 11                                                  |
| DEVICE_STATUS                   | 7B                        | R      | –                                           | 03                                           | 0.11                                                 | 11                                                  |
| I2C_ADDR_DM                     | 7C                        | RW     | –                                           | 00                                           | 0.11                                                 | 11                                                  |

**Notes**

20. **Errata:** Added two on-chip filtering algorithms for improved CapSense performance and better noise immunity.

21. **Errata:** If a finger is on the sensor, during power-up the sensor triggers and the baseline gets stuck. Baseline is stuck only when Averaging Filter is enabled. For more information, see "Errata" on page 40.

22. The register 0x75–0x78, 0x7D and 0x8A–0x8D are reserved.

23. The Device ID for different devices are tabulated in [Device IDs on page 17](#).

**Register Map** (continued)

| Name            | Register Address (in Hex) | Access | Writable Only in SETUP Mode <sup>[16]</sup> | Factory Default Values of Registers (in Hex) | I2C Max ACK Time in Normal Mode (ms) <sup>[17]</sup> | I2C Max ACK Time in Setup Mode (ms) <sup>[17]</sup> |
|-----------------|---------------------------|--------|---------------------------------------------|----------------------------------------------|------------------------------------------------------|-----------------------------------------------------|
|                 | 7D <sup>[25]</sup>        |        |                                             |                                              |                                                      |                                                     |
| SLEEP_PIN       | 7E                        | RW     | YES                                         | 00                                           | 0.1                                                  | 11                                                  |
| SLEEP_CTRL      | 7F                        | RW     | –                                           | 00                                           | 0.1                                                  | 11                                                  |
| SLEEP_SA_CNTR   | 80                        | RW     | –                                           | 00                                           | 0.1                                                  | 11                                                  |
| CS_READ_BUTTON  | 81                        | RW     | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_BLM     | 82                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_BLL     | 83                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_DIFFM   | 84                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_DIFFL   | 85                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_RAWM    | 86                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_RAWL    | 87                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_STATUSM | 88                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
| CS_READ_STATUSL | 89                        | R      | –                                           | 00                                           | 0.12                                                 | 11                                                  |
|                 | 8A <sup>[25]</sup>        |        |                                             |                                              |                                                      |                                                     |
|                 | 8B <sup>[25]</sup>        |        |                                             |                                              |                                                      |                                                     |
|                 | 8C <sup>[25]</sup>        |        |                                             |                                              |                                                      |                                                     |
|                 | 8D <sup>[25]</sup>        |        |                                             |                                              |                                                      |                                                     |
| COMMAND_REG     | A0                        | W      | –                                           | 00                                           | 0.1                                                  | 11                                                  |

**Notes**

24. These registers are writable only after entering into setup mode. All the other registers available for read and write in Normal as well as in Setup mode.  
25. The register 0x75–0x78, 0x7D and 0x8A–0x8D are reserved.

## Device IDs

| Part Number | Device ID |
|-------------|-----------|
| CY8C20142   | 42        |
| CY8C20140   | 40        |
| CY8C20160   | 60        |
| CY8C20180   | 80        |
| CY8C20110   | 10        |

**Note** All the Ack times specified are maximum values with all buttons enabled and filter enabled, with maximum order for 5-V and 3.3-V operation. The timing values for 2.7-V operation will be 4x these values.

## CapSense Express Commands

| Command <sup>[26]</sup>    | Description                        | Executable Mode | Duration the Device is not accessible after ACK (in ms) <sup>[27]</sup> |
|----------------------------|------------------------------------|-----------------|-------------------------------------------------------------------------|
| W 00 A0 00                 | Get firmware revision              | Setup/Normal    | 0                                                                       |
| W 00 A0 01 <sup>[28]</sup> | Store current configuration to NVM | Setup/Normal    | 120                                                                     |
| W 00 A0 02                 | Restore factory configuration      | Setup/Normal    | 120                                                                     |
| W 00 A0 03                 | Write NVM POR defaults             | Setup/Normal    | 120                                                                     |
| W 00 A0 04                 | Read NVM POR defaults              | Setup/Normal    | 5                                                                       |
| W 00 A0 05                 | Read current configurations (RAM)  | Setup/Normal    | 5                                                                       |
| W 00 A0 06                 | Reconfigure device (POR)           | Setup           | 5                                                                       |
| W 00 A0 07                 | Set normal mode of operation       | Setup/Normal    | 0                                                                       |
| W 00 A0 08                 | Set setup mode of operation        | Setup/Normal    | $1.2 * (\text{loop time}^{[29]} + 1 \text{ ms})$                        |
| W 00 A0 09                 | Start scan                         | Setup/Normal    | 10                                                                      |
| W 00 A0 0A                 | Stop scan                          | Setup/Normal    | 5                                                                       |
| W 00 A0 0B                 | Get CapSense scan status           | Setup/Normal    | 0                                                                       |

## Register Conventions

This table lists the register conventions that are specific to this section.

| Convention | Description                             |
|------------|-----------------------------------------|
| RW         | Register has both read and write access |
| R          | Register has only read access           |

### Notes

26. The 'W' indicates the write transfer. The next byte of data represents the 7-bit I2C address.

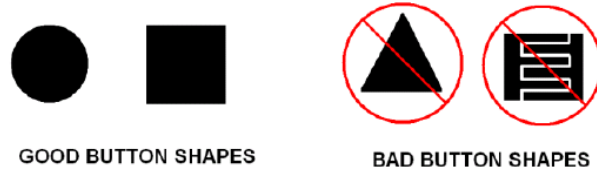
27. The "not accessible" timing values are the maximum values for 5-V and 3.3-V operation. The timing values for 2.7-V operation will be 4x the values provided in this table. Refer to [Operating Voltages on page 21](#).

28. Errata: Save to flash command fails when the sleep interval is set to 512 or 64 Hz. For more information, see ["Errata" on page 40](#).

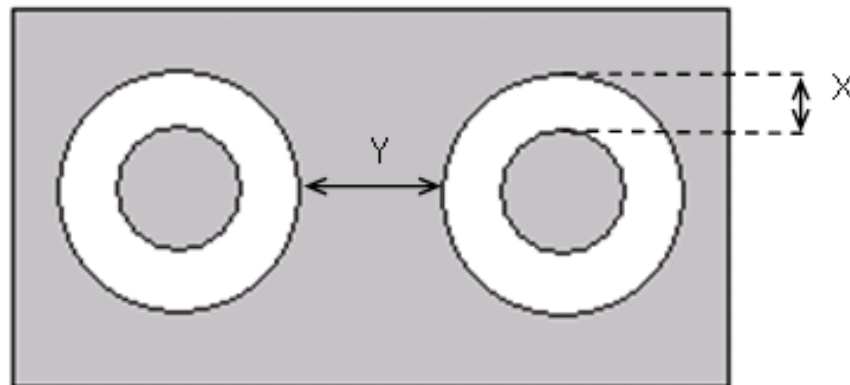
29. Loop time can be measured by probing any sensor using an oscilloscope and measuring the time between two consecutive scans.

## Layout Guidelines and Best Practices

### CapSense Button Shapes



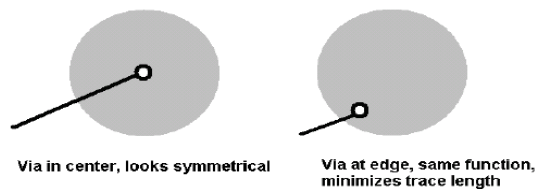
### Button Layout Design



X: Button to ground clearance (Refer to [Table 2 on page 18](#))

Y: Button to button clearance (Refer to [Table 2 on page 18](#))

### Recommended via Hole Placement



**Table 2. Recommended Layout Guidelines and Best Practices**

| S. No. | Category                                 | Min                              | Max     | Recommendations/Remarks                                                |
|--------|------------------------------------------|----------------------------------|---------|------------------------------------------------------------------------|
| 1      | Button shape                             | –                                | –       | Solid round pattern, round with LED hole, rectangle with round corners |
| 2      | Button size                              | 5 mm                             | 15 mm   | 10 mm                                                                  |
| 3      | Button-button spacing                    | Equal to button ground clearance | –       | 8 mm [X]                                                               |
| 4      | Button ground clearance                  | 0.5 mm                           | 2 mm    | Button ground clearance = Overlay thickness [Y]                        |
| 5      | Ground flood-top layer                   | –                                | –       | Hatched ground 7-mil trace and 45-mil grid (15% filling)               |
| 6      | Ground flood-bottom layer                | –                                | –       | Hatched ground 7-mil trace and 70-mil grid (10% filling)               |
| 7      | Trace length from sensor to PSoC-buttons | –                                | 200 mm  | < 100 mm                                                               |
| 8      | Trace width                              | 0.17 mm                          | 0.20 mm | 0.17 mm (7-mil)                                                        |

**Table 2. Recommended Layout Guidelines and Best Practices** *(continued)*

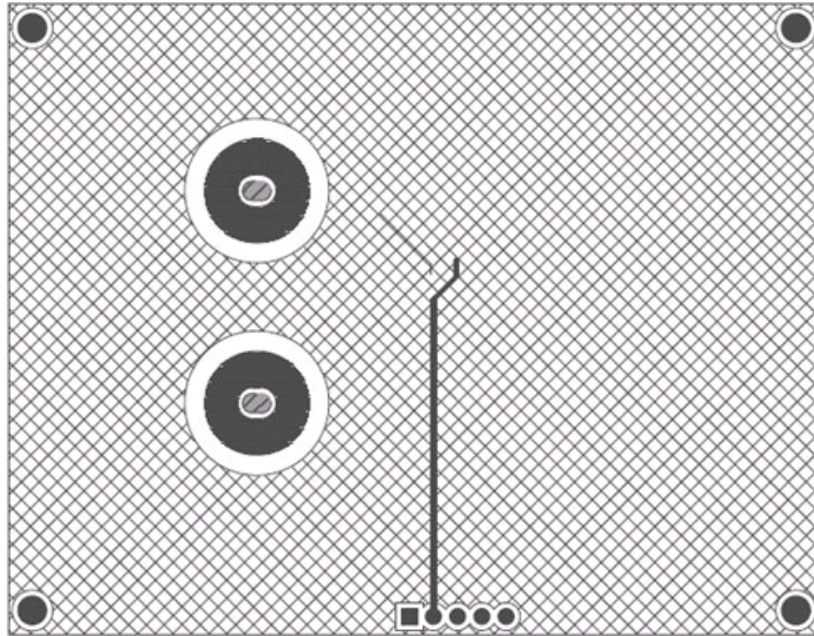
| S. No. | Category                                            | Min    | Max    | Recommendations/Remarks                                                                                                                                        |
|--------|-----------------------------------------------------|--------|--------|----------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 9      | Trace routing                                       | –      | –      | Traces should be routed on the non sensor side. If any non CapSense trace crosses CapSense trace, ensure that intersection is orthogonal.                      |
| 10     | Via position for the sensors                        | –      | –      | Via should be placed near the edge of the button/slider to reduce trace length thereby increasing sensitivity.                                                 |
| 11     | Via hole size for sensor traces                     | –      | –      | 10-mil                                                                                                                                                         |
| 12     | Number of vias on sensor trace                      | 1      | 2      | 1                                                                                                                                                              |
| 13     | CapSense series resistor placement                  | –      | 10 mm  | Place CapSense series resistors close to PSoC for noise suppression. CapSense resistors have highest priority place them first.                                |
| 14     | Distance between any CapSense trace to ground flood | 10-mil | 20-mil | 20-mil                                                                                                                                                         |
| 15     | Device placement                                    | –      | –      | Mount the device on the layer opposite to sensor. The CapSense trace length between the device and sensors should be minimum                                   |
| 16     | Placement of components in 2-layer PCB              | –      | –      | Top layer – sensor pads and<br>bottom layer – PSoC, other components, and traces.                                                                              |
| 17     | Placement of components in 4-layer PCB              | –      | –      | Top layer – sensor pads,<br>second layer – CapSense traces,<br>third layer – hatched ground,<br>bottom layer – PSoC, other components, and non CapSense traces |
| 18     | Overlay material                                    | –      | –      | Should to be non conductive material. Glass, ABS plastic, Formica                                                                                              |
| 19     | Overlay adhesives                                   | –      | –      | Adhesive should be non conductive and dielectrically homogenous. 467MP and 468MP adhesives made by 3M are recommended.                                         |
| 20     | LED back lighting                                   | –      | –      | Cut a hole in the sensor pad and use rear mountable LEDs. Refer the PCB layout below.                                                                          |
| 21     | Board thickness                                     | –      | –      | Standard board thickness for CapSense FR4 based designs is 1.6 mm.                                                                                             |

The recommended maximum overlay thickness is 5 mm (with external CSInt)/ 2 mm (without external CSInt). For more details refer to the section “The Integrating Capacitor (Cint)” in [AN53490](#).

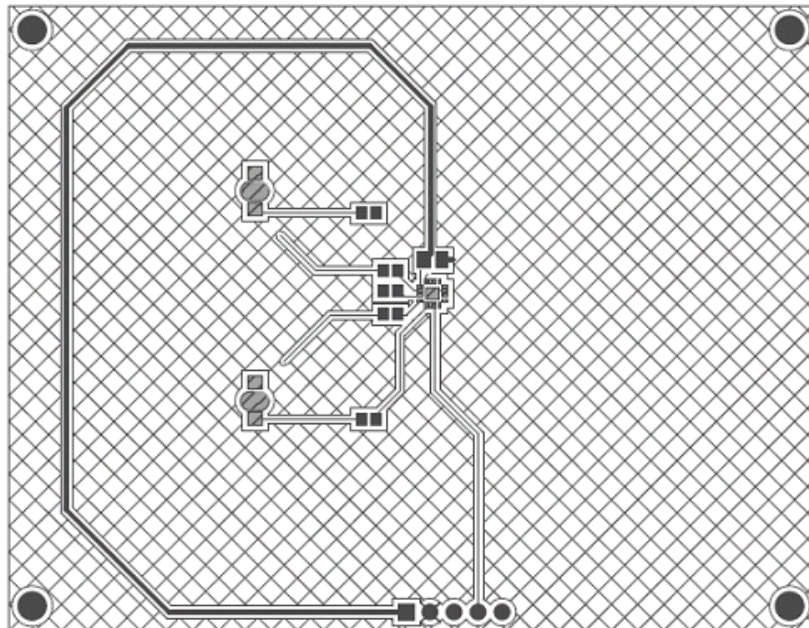
**Note** Some device packages does not have CSInt pin and external capacitor cannot be connected.

**Example PCB Layout Design with Two CapSense Buttons and Two LEDs**

**Figure 10. Top Layer**



**Figure 11. Bottom Layer**



## Operating Voltages

|      |                                 |                                   |                    |                    |
|------|---------------------------------|-----------------------------------|--------------------|--------------------|
| 5.25 |                                 |                                   |                    |                    |
| 4.72 |                                 |                                   |                    |                    |
| 3.60 |                                 |                                   |                    |                    |
| 3.10 |                                 |                                   |                    |                    |
| 3.02 |                                 |                                   |                    |                    |
| 2.90 |                                 |                                   |                    |                    |
| 2.45 |                                 |                                   |                    |                    |
| 2.40 |                                 |                                   |                    |                    |
| 1.80 |                                 |                                   |                    |                    |
| 0    |                                 |                                   |                    |                    |
|      | Valid Device<br>Operating range | Valid CapSense<br>Operating range | I2C 1x<br>Ack mode | I2C 4x<br>Ack mode |

For details on I<sup>2</sup>C 1x ACK time, refer to [Register Map on page 13](#) and [CapSense Express Commands on page 17](#). I<sup>2</sup>C 4x ACK time is approximately four times the values mentioned in these tables.

## CapSense Constraints

| Parameter                                                      | Min | Typ | Max | Units | Notes |
|----------------------------------------------------------------|-----|-----|-----|-------|-------|
| Parasitic capacitance (C <sub>P</sub> ) of the CapSense sensor | –   | –   | 30  | pF    |       |
| Supply voltage variation (V <sub>DD</sub> )                    | –   | –   | ±5% | –     |       |

## Absolute Maximum Ratings

| Parameter             | Description                                                   | Min                   | Typ | Max                   | Unit  | Notes                                                                                                                                                                                             |
|-----------------------|---------------------------------------------------------------|-----------------------|-----|-----------------------|-------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| T <sub>STG</sub>      | Storage temperature                                           | –55                   | 25  | +100                  | °C    | Higher storage temperatures reduce data retention time. Recommended storage temperature is +25 °C ± 25 °C (0 °C to 50 °C). Extended duration storage temperatures above 65 °C degrade reliability |
| T <sub>BAKETEMP</sub> | Bake temperature                                              | –                     | 125 | See Package label     | °C    |                                                                                                                                                                                                   |
| t <sub>BAKETIME</sub> | Bake time                                                     | See package label     | –   | 72                    | Hours |                                                                                                                                                                                                   |
| T <sub>A</sub>        | Ambient temperature with power applied                        | –40                   | –   | +85                   | °C    |                                                                                                                                                                                                   |
| V <sub>DD</sub>       | Supply voltage on V <sub>DD</sub> relative to V <sub>SS</sub> | –0.5                  | –   | +6.0                  | V     |                                                                                                                                                                                                   |
| V <sub>IO</sub>       | DC input voltage                                              | V <sub>SS</sub> – 0.5 | –   | V <sub>DD</sub> + 0.5 | V     |                                                                                                                                                                                                   |
| V <sub>IOZ</sub>      | DC voltage applied to tristate                                | V <sub>SS</sub> – 0.5 | –   | V <sub>DD</sub> + 0.5 | V     |                                                                                                                                                                                                   |
| I <sub>MIO</sub>      | Maximum current into any GPIO pin                             | –25                   | –   | +50                   | mA    |                                                                                                                                                                                                   |
| ESD                   | Electro static discharge voltage                              | 2000                  | –   | –                     | V     | Human body model ESD                                                                                                                                                                              |
| LU                    | Latch-up current                                              | –                     | –   | 200                   | mA    |                                                                                                                                                                                                   |

## Operating Temperature

| Parameter      | Description          | Min | Typ | Max  | Unit | Notes |
|----------------|----------------------|-----|-----|------|------|-------|
| T <sub>A</sub> | Ambient temperature  | –40 | –   | +85  | °C   |       |
| T <sub>J</sub> | Junction temperature | –40 | –   | +100 | °C   |       |

## Electrical Specifications

### DC Electrical Specifications

#### DC Chip-Level Specifications

**Table 3. DC Chip-Level Specifications**

| Parameter       | Description                                     | Min  | Typ | Max  | Unit | Notes                                                           |
|-----------------|-------------------------------------------------|------|-----|------|------|-----------------------------------------------------------------|
| V <sub>DD</sub> | Supply voltage                                  | 2.40 | –   | 5.25 | V    |                                                                 |
| I <sub>DD</sub> | Supply current                                  | –    | 1.5 | 2.5  | mA   | Conditions are V <sub>DD</sub> = 3.10 V, T <sub>A</sub> = 25 °C |
| ISB             | Deep sleep mode current with POR and LVD active | –    | 2.6 | 4    | μA   | V <sub>DD</sub> = 2.55 V, 0 °C < T <sub>A</sub> < 40 °C         |
| ISB             | Deep sleep mode current with POR and LVD active | –    | 2.8 | 5    | μA   | V <sub>DD</sub> = 3.3 V, –40 °C < T <sub>A</sub> < 85 °C        |
| ISB             | Deep sleep mode current with POR and LVD active | –    | 5.2 | 6.4  | μA   | V <sub>DD</sub> = 5.25 V, –40 °C < T <sub>A</sub> < 85 °C       |

#### DC GPIO Specifications

This table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and –40 °C ≤ T<sub>A</sub> ≤ 85 °C, 3.10 V to 3.6 V and –40 °C ≤ T<sub>A</sub> ≤ 85 °C. Typical parameters apply to 5 V and 3.3 V at 25 °C and are for design guidance only.

**Table 4. 5-V and 3.3-V DC GPIO Specifications**

| Parameter        | Description                        | Min                   | Typ | Max  | Unit | Notes                                                                                                                                                                  |
|------------------|------------------------------------|-----------------------|-----|------|------|------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| V <sub>OH1</sub> | High output voltage on Port 0 pins | V <sub>DD</sub> – 0.2 | –   | –    | V    | I <sub>OH</sub> < 10 μA, V <sub>DD</sub> > 3.10 V, maximum of 20 mA source current in all I/Os.                                                                        |
| V <sub>OH2</sub> | High output voltage on Port 0 pins | V <sub>DD</sub> – 0.9 | –   | –    | V    | I <sub>OH</sub> = 1 mA, V <sub>DD</sub> > 3.10 V, maximum of 20 mA source current in all I/Os.                                                                         |
| V <sub>OH3</sub> | High output voltage on Port 1 pins | V <sub>DD</sub> – 0.2 | –   | –    | V    | I <sub>OH</sub> < 10 μA, V <sub>DD</sub> > 3.10 V, maximum of 20 mA source current in all I/Os.                                                                        |
| V <sub>OH4</sub> | High output voltage on Port 1 pins | V <sub>DD</sub> – 0.9 | –   | –    | V    | I <sub>OH</sub> = 5 mA, V <sub>DD</sub> > 3.10 V, maximum of 20 mA source current in all I/Os.                                                                         |
| V <sub>OL</sub>  | Low output voltage                 | –                     | –   | 0.75 | V    | I <sub>OL</sub> = 20 mA/pin, V <sub>DD</sub> > 3.10, maximum of 40/60 mA sink current on even port pins and of 40/60 mA sink current on odd port pins. <sup>[30]</sup> |
| I <sub>OH1</sub> | High output current on Port 0 pins | 0.01                  | –   | 1    | mA   | V <sub>DD</sub> ≥ 3.1 V, maximum of 20 mA source current in all I/Os                                                                                                   |
| I <sub>OH2</sub> | High output current on Port 1 pins | 0.01                  | –   | 5    | mA   | V <sub>DD</sub> ≥ 3.1 V, maximum of 20 mA source current in all I/Os                                                                                                   |
| I <sub>OL</sub>  | Low output current                 | –                     | –   | 20   | mA   | V <sub>DD</sub> ≥ 3.1 V, maximum of 60 mA sink current on pins P0_2, P1_2, P1_3, P1_4 and 60 mA sink current on pins P0_0, P0_1, P0_3, P0_4, P1_0, P1_1                |
| V <sub>IL</sub>  | Input low voltage                  | –                     | –   | 0.75 | V    | V <sub>DD</sub> = 3.10 V to 3.6 V.                                                                                                                                     |
| V <sub>IH</sub>  | Input high voltage                 | 1.6                   | –   | –    | V    | V <sub>DD</sub> = 3.10 V to 3.6 V.                                                                                                                                     |
| V <sub>IL</sub>  | Input low voltage                  | –                     | –   | 0.8  | V    | V <sub>DD</sub> = 4.75 V to 5.25 V.                                                                                                                                    |
| V <sub>IH</sub>  | Input high voltage                 | 2.0                   | –   | –    | V    | V <sub>DD</sub> = 4.75 V to 5.25 V.                                                                                                                                    |

**Note**

30. The maximum sink current is 40 mA for 20140 and 20142 devices and for all other devices the maximum sink current is 60 mA.

**Table 4. 5-V and 3.3-V DC GPIO Specifications (continued)**

| Parameter | Description                       | Min | Typ | Max | Unit | Notes                                       |
|-----------|-----------------------------------|-----|-----|-----|------|---------------------------------------------|
| $V_H$     | Input hysteresis voltage          | –   | 140 | –   | mV   | –                                           |
| $I_{IL}$  | Input leakage                     | –   | 1   | –   | nA   | Gross tested to 1 $\mu$ A.                  |
| $C_{IN}$  | Capacitive load on pins as input  | 0.5 | 1.7 | 5   | pF   | Package and pin dependent.<br>Temp = 25 °C. |
| $C_{OUT}$ | Capacitive load on pins as output | 0.5 | 1.7 | 5   | pF   | Package and pin dependent.<br>Temp = 25 °C. |

This table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 2.4 V to 2.90 V and  $-40\text{ }^{\circ}\text{C} < T_A < 85\text{ }^{\circ}\text{C}$ , respectively. Typical parameters apply to 2.7 V at 25 °C and are for design guidance only.

**Table 5. 2.7-V DC GPIO Specifications**

| Parameter | Description                        | Min            | Typ | Max  | Unit | Notes                                                                                                                                                       |
|-----------|------------------------------------|----------------|-----|------|------|-------------------------------------------------------------------------------------------------------------------------------------------------------------|
| $V_{OH1}$ | High output voltage on Port 0 pins | $V_{DD} - 0.2$ | –   | –    | V    | $I_{OH} < 10\text{ }\mu\text{A}$ , maximum of 10 mA source current in all I/Os.                                                                             |
| $V_{OH2}$ | High output voltage on Port 0 pins | $V_{DD} - 0.5$ | –   | –    | V    | $I_{OH} = 0.2\text{ mA}$ , maximum of 10 mA source current in all I/Os.                                                                                     |
| $V_{OH3}$ | High output voltage on Port 1 pins | $V_{DD} - 0.2$ | –   | –    | V    | $I_{OH} < 10\text{ }\mu\text{A}$ , maximum of 10 mA source current in all I/Os.                                                                             |
| $V_{OH4}$ | High output voltage on Port 1 pins | $V_{DD} - 0.5$ | –   | –    | V    | $I_{OH} = 2\text{ mA}$ , maximum of 10 mA source current in all I/Os.                                                                                       |
| $V_{OL1}$ | Low output voltage                 | –              | –   | 0.75 | V    | $I_{OL} = 10\text{ mA/pin}$ , $V_{DD} > 3.10$ , maximum of 20/30 mA sink current on even port pins and of 20/30 mA sink current on odd port pins. [31]      |
| $I_{OH}$  | High output current                | 0.01           | –   | 2    | mA   | $V_{DD} \leq 2.9\text{ V}$ , maximum of 10 mA source current in all I/Os                                                                                    |
| $I_{OL1}$ | Low output current on Port 0 pins  | –              | –   | 10   | mA   | $V_{DD} \leq 2.9\text{ V}$ , maximum of 30 mA sink current on pins P0_2, P1_2, P1_3, P1_4 and 30 mA sink current on pins P0_0, P0_1, P0_3, P0_4, P1_0, P1_1 |
| $I_{OL2}$ | Low output current                 | –              | –   | 20   | mA   | $V_{DD} \leq 2.9\text{ V}$ , maximum of 50 mA sink current on pins P0_2, P1_2, P1_3, P1_4 and 50 mA sink current on pins P0_0, P0_1, P0_3, P0_4, P1_0, P1_1 |
| $V_{IL}$  | Input low voltage                  | –              | –   | 0.75 | V    | $V_{DD} = 2.4\text{ to }2.90\text{ V and }3.10\text{ V to }3.6\text{ V}$ .                                                                                  |
| $V_{IH1}$ | Input high voltage                 | 1.4            | –   | –    | V    | $V_{DD} = 2.4\text{ to }2.7\text{ V}$ .                                                                                                                     |
| $V_{IH2}$ | Input high voltage                 | 1.6            | –   | –    | V    | $V_{DD} = 2.7\text{ to }2.90\text{ V and }3.10\text{ V to }3.6\text{ V}$ .                                                                                  |
| $V_H$     | Input hysteresis voltage           | –              | 60  | –    | mV   |                                                                                                                                                             |
| $I_{IL}$  | Input leakage                      | –              | 1   | –    | nA   | Gross tested to 1 $\mu$ A.                                                                                                                                  |
| $C_{IN}$  | Capacitive load on pins as input   | 0.5            | 1.7 | 5    | pF   | Package and pin dependent.<br>Temp = 25 °C.                                                                                                                 |
| $C_{OUT}$ | Capacitive load on pins as output  | 0.5            | 1.7 | 5    | pF   | Package and pin dependent.<br>Temp = 25 °C                                                                                                                  |

**Note**

31. The maximum sink current per port is 20 mA for 20140 and 20142 devices and for all other devices the maximum sink current is 30 mA.

#### DC POR and LVD Specifications

**Table 6. DC POR and LVD Specifications**

| Parameter   | Description                               | Min  | Typ  | Max  | Unit | Notes                                                                             |
|-------------|-------------------------------------------|------|------|------|------|-----------------------------------------------------------------------------------|
| $V_{PPOR0}$ | $V_{DD}$ value for PPOR trip              | —    | 2.36 | 2.40 | V    | $V_{DD}$ must be greater than or equal to 2.5 V during startup or internal reset. |
| $V_{PPOR1}$ | $V_{DD} = 2.7$ V<br>$V_{DD} = 3.3$ V, 5 V | —    | 2.60 | 2.65 | V    |                                                                                   |
| $V_{LVD0}$  | $V_{DD}$ value for LVD trip               | —    | —    | —    | —    |                                                                                   |
| $V_{LVD2}$  | $V_{DD} = 2.7$ V                          | 2.39 | 2.45 | 2.51 | V    |                                                                                   |
| $V_{LVD6}$  | $V_{DD} = 3.3$ V                          | 2.75 | 2.92 | 2.99 | V    |                                                                                   |
|             | $V_{DD} = 5$ V                            | 3.98 | 4.05 | 4.12 | V    |                                                                                   |

#### DC Flash Write Specifications

This table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and  $-40^{\circ}\text{C} < T_A < 85^{\circ}\text{C}$ , 3.10 V to 3.6 V and  $-40^{\circ}\text{C} < T_A < 85^{\circ}\text{C}$  or 2.4 V to 2.90 V and  $-40^{\circ}\text{C} < T_A < 85^{\circ}\text{C}$ , respectively. Typical parameters apply to 5 V, 3.3 V, or 2.7 V at  $25^{\circ}\text{C}$ . These are for design guidance only. Flash Endurance and Retention specifications are valid only within the range:  $25^{\circ}\text{C} \pm 20^{\circ}\text{C}$  during the flash write operation. It is at the user's own risk to operate out of this temperature range. If flash writing is done out of this temperature range, the endurance and data retention reduces.

**Table 7. DC Flash Write Specifications**

| Symbol                | Description                               | Min                    | Typ | Max | Units | Notes              |
|-----------------------|-------------------------------------------|------------------------|-----|-----|-------|--------------------|
| $V_{DDIWRITE}$        | Supply voltage for flash write operations | 2.7                    | —   | —   | V     |                    |
| $I_{DDP}$             | Supply current for flash write operations | —                      | 5   | 25  | mA    |                    |
| $\text{Flash}_{ENPB}$ | Flash endurance                           | 50,000 <sup>[32]</sup> | —   | —   | —     | Erase/write cycles |
| $\text{Flash}_{DR}$   | Flash data retention                      | 10                     | —   | —   | Years |                    |

#### DC I<sup>2</sup>C Specifications

This table lists guaranteed maximum and minimum specifications for the voltage and temperature ranges: 4.75 V to 5.25 V and  $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ , 3.10 V to 3.6 V and  $-40^{\circ}\text{C} \leq T_A \leq 85^{\circ}\text{C}$ . Typical parameters apply to 5 V and 3.3 V at  $25^{\circ}\text{C}$  and are for design guidance only.

**Table 8. DC I<sup>2</sup>C Specifications**

| Symbol <sup>[33]</sup> | Description                              | Min                 | Typ | Max                  | Units      | Notes                                                                                            |
|------------------------|------------------------------------------|---------------------|-----|----------------------|------------|--------------------------------------------------------------------------------------------------|
| $V_{ILI2C}$            | Input low level                          | —                   | —   | $0.3 \times V_{DD}$  | V          | $2.4 \text{ V} \leq V_{DD} \leq 2.9 \text{ V}$<br>$3.1 \text{ V} \leq V_{DD} \leq 3.6 \text{ V}$ |
|                        |                                          | —                   | —   | $0.25 \times V_{DD}$ | V          | $4.75 \text{ V} \leq V_{DD} \leq 5.25 \text{ V}$                                                 |
| $V_{IHI2C}$            | Input high level                         | $0.7 \times V_{DD}$ | —   | —                    | V          | $2.4 \text{ V} \leq V_{DD} \leq 5.25 \text{ V}$                                                  |
| $V_{OLP}$              | Low output voltage                       | —                   | —   | 0.4                  | V          | $I_{OL} = 5 \text{ mA/pin}$                                                                      |
| $C_{I2C}$              | Capacitive load on I <sup>2</sup> C pins | 0.5                 | 1.7 | 5                    | pF         | Package and pin dependent.<br>Temp = $25^{\circ}\text{C}$ .                                      |
| $R_{PU}$               | Pull-up resistor                         | 4                   | 5.6 | 8                    | k $\Omega$ | —                                                                                                |

#### Notes

32. Commands involving flash writes (0x01, 0x02, 0x03) and flash read (0x04) must be executed only within the same  $V_{CC}$  voltage range detected at POR (power on, or command 0x06) and above 2.7 V.

33. All GPIOs meet the DC GPIO  $V_{IL}$  and  $V_{IH}$  specifications found in the DC GPIO Specifications sections. The I<sup>2</sup>C GPIO pins also meet the above specs.

## CapSense Electrical Characteristics

| Max (V) | Typ (V) | Min (V) | Conditions for Supply Voltage | Result                                                                                    |
|---------|---------|---------|-------------------------------|-------------------------------------------------------------------------------------------|
| 3.6     | 3.3     | 3.1     | < 2.9                         | The device automatically reconfigures itself to work in 2.7 V mode of operation.          |
|         |         |         | > 2.9 or < 3.10               | This range is not recommended for CapSense usage.                                         |
| 2.90    | 2.7     | 2.45    | < 2.45 V                      | The scanning for CapSense parameters shuts down until the voltage returns to over 2.45 V. |
|         |         |         | > 3.10                        | The device automatically reconfigures itself to work in 3.3 V mode of operation.          |
|         |         |         | < 2.4 V                       | The device goes into reset.                                                               |
| 5.25    | 5.0     | 4.75    | < 4.73 V                      | The scanning for CapSense parameters shuts down until the voltage returns to over 4.73 V. |

## AC Electrical Specifications

### AC Chip-Level Specifications

**Table 9. 5-V and 3.3-V AC Chip-Level Specifications**

| Parameter              | Description                                   | Min | Typ | Max | Units | Notes                                                                 |
|------------------------|-----------------------------------------------|-----|-----|-----|-------|-----------------------------------------------------------------------|
| F <sub>32K1</sub>      | Internal low-speed oscillator (ILO) frequency | 15  | 32  | 64  | kHz   | Calculations during sleep operations are done based on ILO frequency. |
| t <sub>XRST</sub>      | External reset pulse width                    | 10  | —   | —   | μs    |                                                                       |
| t <sub>POWERUP</sub>   | Time from end of POR to CPU executing code    | —   | 150 | —   | ms    |                                                                       |
| SR <sub>POWER_UP</sub> | Power supply slew rate                        | —   | —   | 250 | V/ms  |                                                                       |

**Table 10. 2.7-V AC Chip-Level Specifications**

| Parameter              | Description                                | Min | Typ | Max | Units | Notes                                                                 |
|------------------------|--------------------------------------------|-----|-----|-----|-------|-----------------------------------------------------------------------|
| F <sub>32K1</sub>      | ILO frequency                              | 8   | 32  | 96  | kHz   | Calculations during sleep operations are done based on ILO frequency. |
| t <sub>XRST</sub>      | External reset pulse width                 | 10  | —   | —   | μs    |                                                                       |
| t <sub>POWERUP</sub>   | Time from end of POR to CPU executing code | —   | 600 | —   | ms    |                                                                       |
| SR <sub>POWER_UP</sub> | Power supply slew rate                     | —   | —   | 250 | V/ms  |                                                                       |

*AC GPIO Specifications*

**Table 11. 5-V and 3.3-V AC GPIO Specifications**

| Parameter   | Description                                     | Min | Max | Unit | Notes                                                                                             |
|-------------|-------------------------------------------------|-----|-----|------|---------------------------------------------------------------------------------------------------|
| $t_{Rise0}$ | Rise time, strong mode, Load = 50 pF, Port 0    | 15  | 80  | ns   | $V_{DD} = 3.10\text{ V to }3.6\text{ V and }4.75\text{ V to }5.25\text{ V, }10\% \text{ to }90\%$ |
| $t_{Rise1}$ | Rise time, strong mode, Load = 50 pF, Port 1    | 15  | 50  | ns   | $V_{DD} = 3.10\text{ V to }3.6\text{ V, }10\% \text{ to }90\%$                                    |
| $t_{Fall}$  | Fall time, strong mode, Load = 50 pF, all ports | 10  | 50  | ns   | $V_{DD} = 3.10\text{ V to }3.6\text{ V and }4.75\text{ V to }5.25\text{ V, }10\% \text{ to }90\%$ |

**Table 12. 2.7-V AC GPIO Specifications**

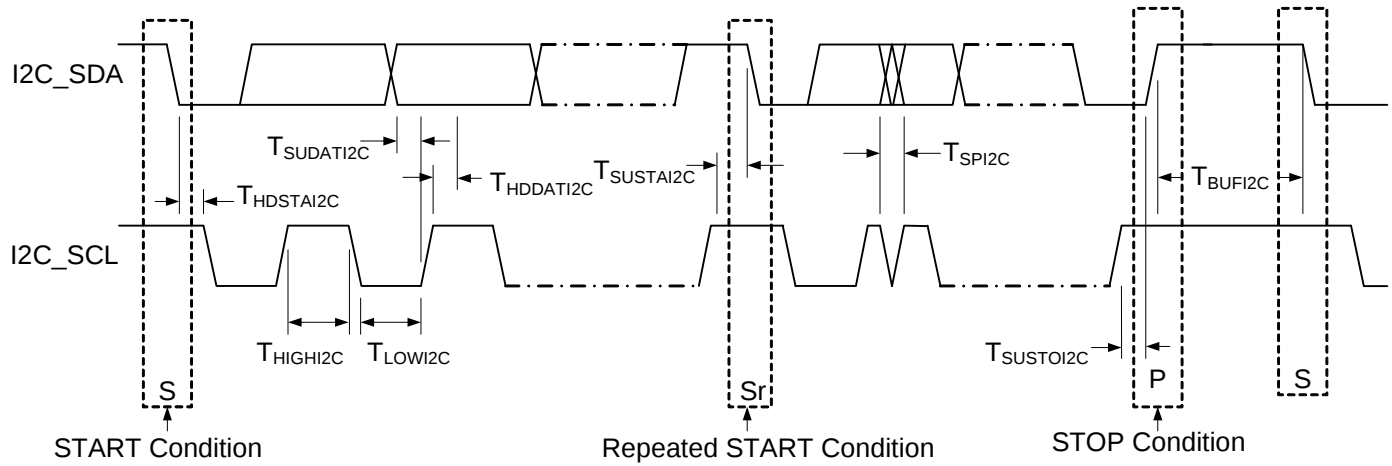
| Parameter   | Description                                  | Min | Max | Unit | Notes                                                          |
|-------------|----------------------------------------------|-----|-----|------|----------------------------------------------------------------|
| $t_{Rise0}$ | Rise time, strong mode, Load = 50 pF, Port 0 | 15  | 100 | ns   | $V_{DD} = 2.4\text{ V to }2.90\text{ V, }10\% \text{ to }90\%$ |
| $t_{Rise1}$ | Rise time, strong mode, Load = 50 pF, Port 1 | 15  | 70  | ns   | $V_{DD} = 2.4\text{ V to }2.90\text{ V, }10\% \text{ to }90\%$ |
| $t_{Fall}$  | Fall time, strong mode, Load = 50 pF         | 10  | 70  | ns   | $V_{DD} = 2.4\text{ V to }2.90\text{ V, }10\% \text{ to }90\%$ |

*AC I<sup>2</sup>C Specifications*

**Table 13. AC I<sup>2</sup>C Specifications**

| Parameter          | Description                                                                                 | Standard Mode |     | Fast Mode |     | Units | Notes                                                 |
|--------------------|---------------------------------------------------------------------------------------------|---------------|-----|-----------|-----|-------|-------------------------------------------------------|
|                    |                                                                                             | Min           | Max | Min       | Max |       |                                                       |
| $F_{SCL}^{I^2C}$   | SCL clock frequency                                                                         | 0             | 100 | 0         | 400 | kbps  | Fast mode not supported for $V_{DD} < 3.0\text{ V}$ . |
| $t_{HDSTA}^{I^2C}$ | Hold time (repeated) START condition. After this period, the first clock pulse is generated | 4.0           | —   | 0.6       | —   | μs    |                                                       |
| $t_{LOW}^{I^2C}$   | LOW period of the SCL clock                                                                 | 4.7           | —   | 1.3       | —   | μs    |                                                       |
| $t_{HIGH}^{I^2C}$  | HIGH period of the SCL clock                                                                | 4.0           | —   | 0.6       | —   | μs    |                                                       |
| $t_{SUSTA}^{I^2C}$ | Setup time for a repeated START condition                                                   | 4.7           | —   | 0.6       | —   | μs    |                                                       |
| $t_{HDDAT}^{I^2C}$ | Data hold time                                                                              | 0             | —   | 0         | —   | μs    |                                                       |
| $t_{SUDAT}^{I^2C}$ | Data setup time                                                                             | 250           | —   | 100       | —   | ns    |                                                       |
| $t_{SUSTO}^{I^2C}$ | Setup time for STOP condition                                                               | 4.0           | —   | 0.6       | —   | μs    |                                                       |
| $t_{BUF}^{I^2C}$   | BUS free time between a STOP and START condition                                            | 4.7           | —   | 1.3       | —   | μs    |                                                       |
| $t_{Sp}^{I^2C}$    | Pulse width of spikes suppressed by the input filter                                        | —             | —   | 0         | 50  | ns    |                                                       |

**Figure 12. Definition of Timing for Fast/Standard Mode on the I<sup>2</sup>C Bus**



## Appendix

### Examples of Frequently Used I<sup>2</sup>C Commands

| S. No. | Requirement                                                           | I <sup>2</sup> C commands <sup>[34]</sup>            | Comment                                                                                                                                                                                           |
|--------|-----------------------------------------------------------------------|------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1      | Enter into setup mode                                                 | W 00 A0 08                                           |                                                                                                                                                                                                   |
| 2      | Enter into normal mode                                                | W 00 A0 07                                           |                                                                                                                                                                                                   |
| 3      | Load factory defaults to RAM registers                                | W 00 A0 02                                           |                                                                                                                                                                                                   |
| 4      | Do a software reset                                                   | W 00 A0 08<br>W 00 A0 06                             | Enter into setup mode<br>Do software reset                                                                                                                                                        |
| 5      | Save current configuration to flash <sup>[35]</sup>                   | W 00 A0 01                                           |                                                                                                                                                                                                   |
| 6      | Load factory defaults to RAM registers and save as user configuration | W 00 A0 08<br>W 00 A0 02<br>W 00 A0 01<br>W 00 A0 06 | Enter into setup mode<br>Load factory defaults to SRAM<br>Save the configuration to flash. Wait for time specified in <a href="#">CapSense Express Commands on page 17</a> .<br>Do software reset |
| 7      | Enable GP00 as CapSense button                                        | W 00 A0 08<br>W 00 06 01<br>W 00 A0 01<br>W 00 A0 06 | Enter into setup mode<br>Configuring CapSense buttons<br>Save the configuration to flash. Wait for time specified in <a href="#">CapSense Express Commands on page 17</a> .<br>Do software reset  |
| 8      | Read CapSense button(GP00) scan results                               | W 00 81 01<br>W 00 82<br>R 00 RD. RD. RD.            | Select CapSense button for reading scan result<br>Set the read point to 82h<br>Consecutive 6 reads get baseline, difference count and raw count (all two byte each)                               |
| 9      | Read CapSense button status register                                  | W 00 88<br>R 00 RD                                   | Set the read pointer to 88<br>Reading a byte gets status CapSense inputs                                                                                                                          |

#### Notes

34. The 'W' indicates the write transfer and the next byte of data represents the 7-bit I<sup>2</sup>C address. The I<sup>2</sup>C address is assumed to be '0' in the above examples. Similarly 'R' indicates the read transfer followed by 7-bit address and data byte read operations.

35. **Errata:** Save to flash command fails when the sleep interval is set to 512 or 64 Hz. For more information, see ["Errata"](#) on page 40.

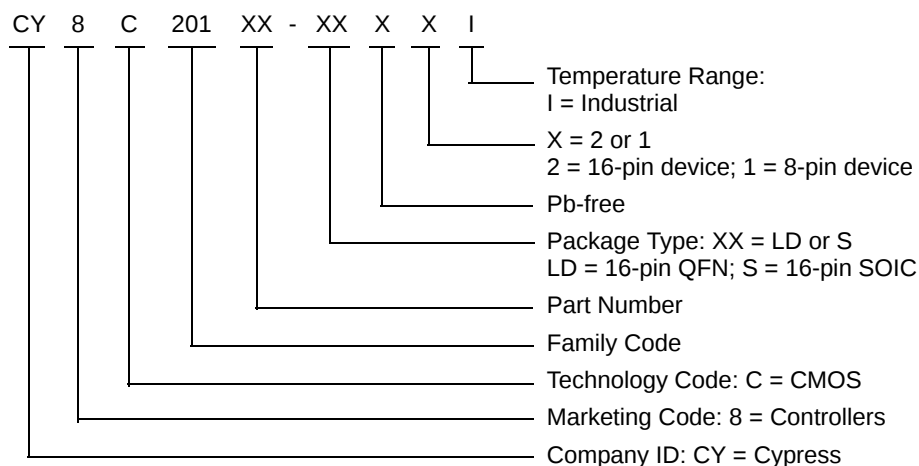
## Ordering Information

**Table 14. Key Features and Ordering Information**

| Ordering Code   | Package Diagram | Package Type               | Operating Temperature | CapSense Block | GPIOs | XRES Pin |
|-----------------|-----------------|----------------------------|-----------------------|----------------|-------|----------|
| CY8C20110-LDX2I | 001-09116       | 16-pin QFN <sup>[36]</sup> | Industrial            | Yes            | 10    | Yes      |
| CY8C20110-SX2I  | 51-85068        | 16-pin SOIC                | Industrial            | Yes            | 10    | Yes      |
| CY8C20180-LDX2I | 001-09116       | 16-pin QFN <sup>[36]</sup> | Industrial            | Yes            | 08    | Yes      |
| CY8C20180-SX2I  | 51-85068        | 16-pin SOIC                | Industrial            | Yes            | 08    | Yes      |
| CY8C20160-LDX2I | 001-09116       | 16-pin QFN <sup>[36]</sup> | Industrial            | Yes            | 06    | Yes      |
| CY8C20160-SX2I  | 51-85068        | 16-pin SOIC                | Industrial            | Yes            | 06    | Yes      |
| CY8C20140-LDX2I | 001-09116       | 16-pin QFN <sup>[36]</sup> | Industrial            | Yes            | 04    | Yes      |
| CY8C20140-SX2I  | 51-85068        | 16-pin SOIC                | Industrial            | Yes            | 04    | Yes      |
| CY8C20142-SX1I  | 51-85066        | 8-pin SOIC                 | Industrial            | Yes            | 04    | No       |

**Note** For die sales information, contact a local Cypress sales office or Field Applications Engineer (FAE).

### Ordering Code Definitions



**Note**

<sup>36</sup>. Earlier termed as COL.

## Thermal Impedances

**Table 15. Thermal Impedances by Package**

| Package       | Typical $\theta_{JA}$ <sup>[37]</sup> |
|---------------|---------------------------------------|
| 16-pin QFN[1] | 46 °C/W                               |
| 16-pin SOIC   | 79.96 °C/W                            |
| 8-pin SOIC    | 127.22 °C/W                           |

## Solder Reflow Specifications

**Table 16. Solder Reflow Specifications**

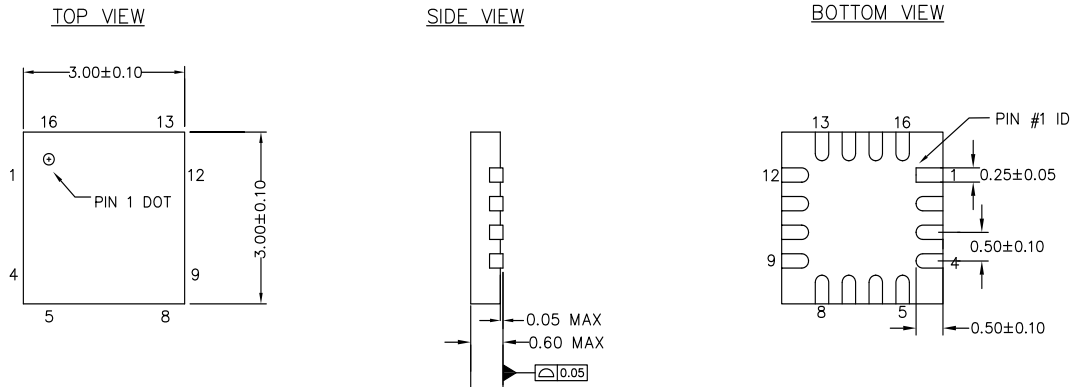
| Package       | Maximum Peak Temperature ( $T_C$ ) | Maximum Time above $T_C - 5$ °C |
|---------------|------------------------------------|---------------------------------|
| 16-pin QFN[1] | 260 °C                             | 30 seconds                      |
| 16-pin SOIC   | 260 °C                             | 30 seconds                      |
| 8-pin SOIC    | 260 °C                             | 30 seconds                      |

**Note**

37.  $T_J = T_A + \text{Power} \times \theta_{JA}$ .

## Package Diagrams

**Figure 13. 16-pin Chip On Lead (3 × 3 × 0.6 mm) LG16A/LD16A (Sawn) Package Outline, 001-09116**

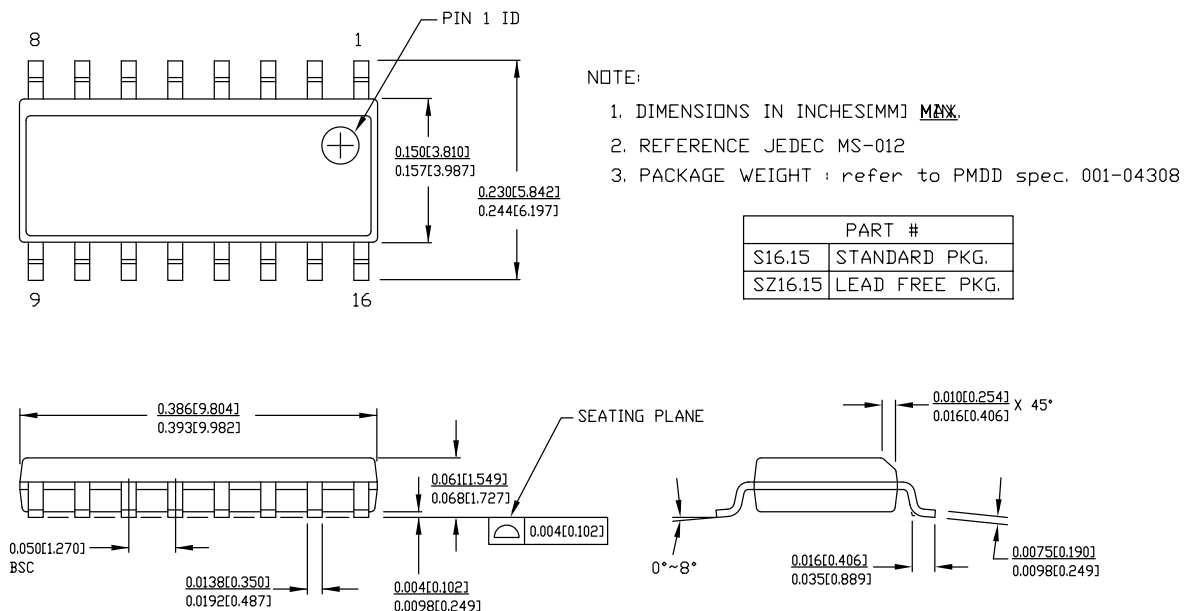


### NOTES

1. REFERENCE JEDEC # MO-220
2. ALL DIMENSIONS ARE IN MILLIMETERS

001-09116 \*J

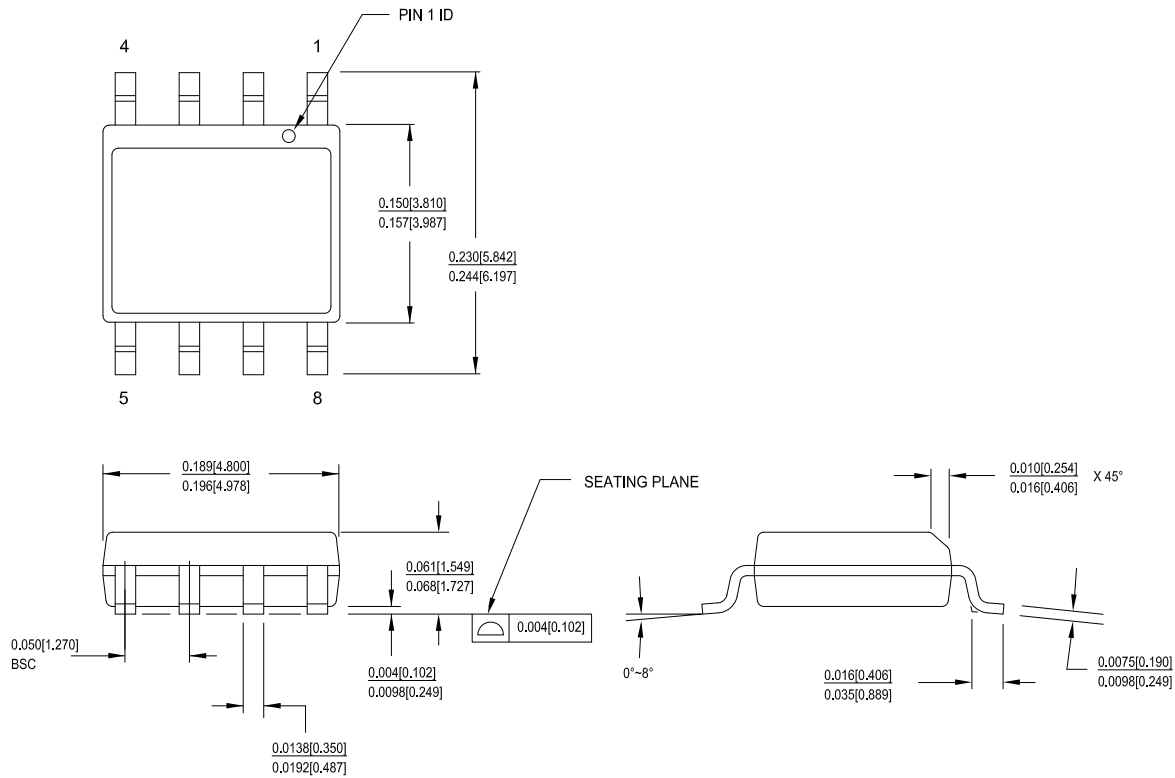
**Figure 14. 16-pin SOIC (150 Mils) S16.15/SZ16.15 Package Outline, 51-85068**



51-85068 \*E

**Package Diagrams** *(continued)*

**Figure 15. 8-pin SOIC (150 Mils) S08.15/SZ08.15 Package Outline, 51-85066**



51-85066 \*F

## Acronyms

Table 17 lists the acronyms that are used in this document.

**Table 17. Acronyms Used in this Datasheet**

| Acronym | Description                                         | Acronym           | Description                      |
|---------|-----------------------------------------------------|-------------------|----------------------------------|
| AC      | alternating current                                 | LVD               | low voltage detect               |
| CMOS    | complementary metal oxide semiconductor             | MCU               | microcontroller unit             |
| DC      | direct current                                      | PCB               | printed circuit board            |
| EEPROM  | electrically erasable programmable read-only memory | POR               | power on reset                   |
| EMC     | electromagnetic compatibility                       | PPOR              | precision power on reset         |
| GPIO    | general-purpose I/O                                 | PSoC <sup>®</sup> | Programmable System-on-Chip      |
| I/O     | input/output                                        | PWM               | pulse width modulator            |
| IDAC    | current DAC                                         | QFN               | quad flat no leads               |
| ILO     | internal low speed oscillator                       | RF                | radio frequency                  |
| LCD     | liquid crystal display                              | SOIC              | small-outline integrated circuit |
| LDO     | low dropout regulator                               | SRAM              | static random access memory      |
| LED     | light-emitting diode                                | XRES              | external reset                   |
| LSB     | least-significant bit                               |                   |                                  |

## Reference Documents

Capsense<sup>®</sup> Express<sup>™</sup> Power And Sleep Considerations - AN44209 (001-44209)

Application Notes for Surface Mount Assembly of Amkor's MicroLeadFrame (MLF) Packages – available at <http://www.amkor.com>.

## Document Conventions

### Units of Measure

Table 18 lists the units of measures.

**Table 18. Units of Measure**

| Symbol | Unit of Measure       | Symbol | Unit of Measure |
|--------|-----------------------|--------|-----------------|
| °C     | degree Celsius        | mm     | millimeter      |
| Hz     | hertz                 | ms     | millisecond     |
| kbps   | kilo bits per second  | mV     | millivolt       |
| kHz    | kilohertz             | nA     | nanoampere      |
| kΩ     | kilohm                | ns     | nanosecond      |
| LSB    | least significant bit | %      | percent         |
| μA     | microampere           | pF     | picofarad       |
| μF     | microfarad            | V      | volt            |
| μs     | microsecond           | W      | watt            |
| mA     | milliampere           |        |                 |

### Numeric Conventions

Hexadecimal numbers are represented with all letters in uppercase with an appended lowercase 'h' (for example, '14h' or '3Ah'). Hexadecimal numbers may also be represented by a '0x' prefix, the C coding convention. Binary numbers have an appended lowercase 'b' (for example, '01010100b' or '01000011b'). Numbers not indicated by an 'h' or 'b' are decimals.

## Glossary

|                                         |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
|-----------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| active high                             | <ol style="list-style-type: none"> <li>1. A logic signal having its asserted state as the logic 1 state.</li> <li>2. A logic signal having the logic 1 state as the higher voltage of the two states.</li> </ol>                                                                                                                                                                                                                                                                                                                |
| analog blocks                           | The basic programmable opamp circuits. These are SC (switched capacitor) and CT (continuous time) blocks. These blocks can be interconnected to provide ADCs, DACs, multi-pole filters, gain stages, and much more.                                                                                                                                                                                                                                                                                                             |
| analog-to-digital (ADC)                 | A device that changes an analog signal to a digital signal of corresponding magnitude. Typically, an ADC converts a voltage to a digital number. The digital-to-analog (DAC) converter performs the reverse operation.                                                                                                                                                                                                                                                                                                          |
| Application programming interface (API) | A series of software routines that comprise an interface between a computer application and lower level services and functions (for example, user modules and libraries). APIs serve as building blocks for programmers that create software applications.                                                                                                                                                                                                                                                                      |
| asynchronous                            | A signal whose data is acknowledged or acted upon immediately, irrespective of any clock signal.                                                                                                                                                                                                                                                                                                                                                                                                                                |
| Bandgap reference                       | A stable voltage reference design that matches the positive temperature coefficient of $V_T$ with the negative temperature coefficient of $V_{BE}$ , to produce a zero temperature coefficient (ideally) reference.                                                                                                                                                                                                                                                                                                             |
| bandwidth                               | <ol style="list-style-type: none"> <li>1. The frequency range of a message or information processing system measured in hertz.</li> <li>2. The width of the spectral region over which an amplifier (or absorber) has substantial gain (or loss); it is sometimes represented more specifically as, for example, full width at half maximum.</li> </ol>                                                                                                                                                                         |
| bias                                    | <ol style="list-style-type: none"> <li>1. A systematic deviation of a value from a reference value.</li> <li>2. The amount by which the average of a set of values departs from a reference value.</li> <li>3. The electrical, mechanical, magnetic, or other force (field) applied to a device to establish a reference level to operate the device.</li> </ol>                                                                                                                                                                |
| block                                   | <ol style="list-style-type: none"> <li>1. A functional unit that performs a single function, such as an oscillator.</li> <li>2. A functional unit that may be configured to perform one of several functions, such as a digital PSoC block or an analog PSoC block.</li> </ol>                                                                                                                                                                                                                                                  |
| buffer                                  | <ol style="list-style-type: none"> <li>1. A storage area for data that is used to compensate for a speed difference, when transferring data from one device to another. Usually refers to an area reserved for I/O operations, into which data is read, or from which data is written.</li> <li>2. A portion of memory set aside to store data, often before it is sent to an external device or as it is received from an external device.</li> <li>3. An amplifier used to lower the output impedance of a system.</li> </ol> |
| bus                                     | <ol style="list-style-type: none"> <li>1. A named connection of nets. Bundling nets together in a bus makes it easier to route nets with similar routing patterns.</li> <li>2. A set of signals performing a common function and carrying similar data. Typically represented using vector notation; for example, address[7:0].</li> <li>3. One or more conductors that serve as a common connection for a group of related devices.</li> </ol>                                                                                 |
| clock                                   | The device that generates a periodic signal with a fixed frequency and duty cycle. A clock is sometimes used to synchronize different logic blocks.                                                                                                                                                                                                                                                                                                                                                                             |
| comparator                              | An electronic circuit that produces an output voltage or current whenever two input levels simultaneously satisfy predetermined amplitude requirements.                                                                                                                                                                                                                                                                                                                                                                         |
| compiler                                | A program that translates a high level language, such as C, into machine language.                                                                                                                                                                                                                                                                                                                                                                                                                                              |

## Glossary *(continued)*

|                               |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|-------------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| configuration space           | In PSoC devices, the register space accessed when the XIO bit, in the CPU_F register, is set to '1'.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| crystal oscillator            | An oscillator in which the frequency is controlled by a piezoelectric crystal. Typically a piezoelectric crystal is less sensitive to ambient temperature than other circuit components.                                                                                                                                                                                                                                                                                                                                                                                                            |
| cyclic redundancy check (CRC) | A calculation used to detect errors in data communications, typically performed using a linear feedback shift register. Similar calculations may be used for a variety of other purposes such as data compression.                                                                                                                                                                                                                                                                                                                                                                                  |
| data bus                      | A bi-directional set of signals used by a computer to convey information from a memory location to the central processing unit and vice versa. More generally, a set of signals used to convey data between digital functions.                                                                                                                                                                                                                                                                                                                                                                      |
| debugger                      | A hardware and software system that allows you to analyze the operation of the system under development. A debugger usually allows the developer to step through the firmware one step at a time, set break points, and analyze memory.                                                                                                                                                                                                                                                                                                                                                             |
| dead band                     | A period of time when neither of two or more signals are in their active state or in transition.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                    |
| digital blocks                | The 8-bit logic blocks that can act as a counter, timer, serial receiver, serial transmitter, CRC generator, pseudo-random number generator, or SPI.                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| digital-to-analog (DAC)       | A device that changes a digital signal to an analog signal of corresponding magnitude. The analog-to-digital (ADC) converter performs the reverse operation.                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| duty cycle                    | The relationship of a clock period high time to its low time, expressed as a percent.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| emulator                      | Duplicates (provides an emulation of) the functions of one system with a different system, so that the second system appears to behave like the first system.                                                                                                                                                                                                                                                                                                                                                                                                                                       |
| External Reset (XRES)         | An active high signal that is driven into the PSoC device. It causes all operation of the CPU and blocks to stop and return to a pre-defined state.                                                                                                                                                                                                                                                                                                                                                                                                                                                 |
| Flash                         | An electrically programmable and erasable, non-volatile technology that provides you the programmability and data storage of EPROMs, plus in-system erasability. Non-volatile means that the data is retained when power is OFF.                                                                                                                                                                                                                                                                                                                                                                    |
| Flash block                   | The smallest amount of Flash ROM space that may be programmed at one time and the smallest amount of Flash space that may be protected. A Flash block holds 64 bytes.                                                                                                                                                                                                                                                                                                                                                                                                                               |
| frequency                     | The number of cycles or events per unit of time, for a periodic function.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                           |
| gain                          | The ratio of output current, voltage, or power to input current, voltage, or power, respectively. Gain is usually expressed in dB.                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| I <sup>2</sup> C              | A two-wire serial computer bus by Philips Semiconductors (now NXP Semiconductors). I <sup>2</sup> C is an Inter-Integrated Circuit. It is used to connect low-speed peripherals in an embedded system. The original system was created in the early 1980s as a battery control interface, but it was later used as a simple internal bus system for building control electronics. I <sup>2</sup> C uses only two bi-directional pins, clock and data, both running at +5 V and pulled high with resistors. The bus operates at 100 kbits/second in standard mode and 400 kbits/second in fast mode. |
| ICE                           | The in-circuit emulator that allows you to test the project in a hardware environment, while viewing the debugging device activity in a software environment (PSoC Designer).                                                                                                                                                                                                                                                                                                                                                                                                                       |
| input/output (I/O)            | A device that introduces data into or extracts data from a system.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                  |

## Glossary (continued)

|                                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|---------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| interrupt                       | A suspension of a process, such as the execution of a computer program, caused by an event external to that process, and performed in such a way that the process can be resumed.                                                                                                                                                                                                                                                                                                                                    |
| interrupt service routine (ISR) | A block of code that normal code execution is diverted to when the M8C receives a hardware interrupt. Many interrupt sources may each exist with its own priority and individual ISR code block. Each ISR code block ends with the RETI instruction, returning the device to the point in the program where it left normal program execution.                                                                                                                                                                        |
| jitter                          | <ol style="list-style-type: none"> <li>1. A misplacement of the timing of a transition from its ideal position. A typical form of corruption that occurs on serial data streams.</li> <li>2. The abrupt and unwanted variations of one or more signal characteristics, such as the interval between successive pulses, the amplitude of successive cycles, or the frequency or phase of successive cycles.</li> </ol>                                                                                                |
| low-voltage detect (LVD)        | A circuit that senses $V_{DD}$ and provides an interrupt to the system when $V_{DD}$ falls lower than a selected threshold.                                                                                                                                                                                                                                                                                                                                                                                          |
| M8C                             | An 8-bit Harvard-architecture microprocessor. The microprocessor coordinates all activity inside a PSoC by interfacing to the Flash, SRAM, and register space.                                                                                                                                                                                                                                                                                                                                                       |
| master device                   | A device that controls the timing for data exchanges between two devices. Or when devices are cascaded in width, the master device is the one that controls the timing for data exchanges between the cascaded devices and an external interface. The controlled device is called the <b>slave device</b> .                                                                                                                                                                                                          |
| microcontroller                 | An integrated circuit chip that is designed primarily for control systems and products. In addition to a CPU, a microcontroller typically includes memory, timing circuits, and I/O circuitry. The reason for this is to permit the realization of a controller with a minimal quantity of chips, thus achieving maximal possible miniaturization. This in turn, reduces the volume and the cost of the controller. The microcontroller is normally not used for general-purpose computation as is a microprocessor. |
| mixed-signal                    | The reference to a circuit containing both analog and digital techniques and components.                                                                                                                                                                                                                                                                                                                                                                                                                             |
| modulator                       | A device that imposes a signal on a carrier.                                                                                                                                                                                                                                                                                                                                                                                                                                                                         |
| noise                           | <ol style="list-style-type: none"> <li>1. A disturbance that affects a signal and that may distort the information carried by the signal.</li> <li>2. The random variations of one or more characteristics of any entity such as voltage, current, or data.</li> </ol>                                                                                                                                                                                                                                               |
| oscillator                      | A circuit that may be crystal controlled and is used to generate a clock frequency.                                                                                                                                                                                                                                                                                                                                                                                                                                  |
| parity                          | A technique for testing transmitting data. Typically, a binary digit is added to the data to make the sum of all the digits of the binary data either always even (even parity) or always odd (odd parity).                                                                                                                                                                                                                                                                                                          |
| Phase-locked loop (PLL)         | An electronic circuit that controls an <b>oscillator</b> so that it maintains a constant phase angle relative to a reference signal.                                                                                                                                                                                                                                                                                                                                                                                 |
| pinouts                         | The pin number assignment: the relation between the logical inputs and outputs of the PSoC device and their physical counterparts in the printed circuit board (PCB) package. Pinouts involve pin numbers as a link between schematic and PCB design (both being computer generated files) and may also involve pin names.                                                                                                                                                                                           |
| port                            | A group of pins, usually eight.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| Power on reset (POR)            | A circuit that forces the PSoC device to reset when the voltage is lower than a pre-set level. This is a type of hardware reset.                                                                                                                                                                                                                                                                                                                                                                                     |
| PSoC®                           | Cypress Semiconductor's PSoC® is a registered trademark and Programmable System-on-Chip™ is a trademark of Cypress.                                                                                                                                                                                                                                                                                                                                                                                                  |

## Glossary (continued)

|                             |                                                                                                                                                                                                                                                                                                                                                     |
|-----------------------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| PSoC Designer™              | The software for Cypress' Programmable System-on-Chip technology.                                                                                                                                                                                                                                                                                   |
| pulse width modulator (PWM) | An output in the form of duty cycle which varies as a function of the applied measurand                                                                                                                                                                                                                                                             |
| RAM                         | An acronym for random access memory. A data-storage device from which data can be read out and new data can be written in.                                                                                                                                                                                                                          |
| register                    | A storage device with a specific capacity, such as a bit or byte.                                                                                                                                                                                                                                                                                   |
| reset                       | A means of bringing a system back to a know state. See hardware reset and software reset.                                                                                                                                                                                                                                                           |
| ROM                         | An acronym for read only memory. A data-storage device from which data can be read out, but new data cannot be written in.                                                                                                                                                                                                                          |
| serial                      | <ol style="list-style-type: none"> <li>1. Pertaining to a process in which all events occur one after the other.</li> <li>2. Pertaining to the sequential or consecutive occurrence of two or more related activities in a single device or channel.</li> </ol>                                                                                     |
| settling time               | The time it takes for an output signal or value to stabilize after the input has changed from one value to another.                                                                                                                                                                                                                                 |
| shift register              | A memory storage device that sequentially shifts a word either left or right to output a stream of serial data.                                                                                                                                                                                                                                     |
| slave device                | A device that allows another device to control the timing for data exchanges between two devices. Or when devices are cascaded in width, the slave device is the one that allows another device to control the timing of data exchanges between the cascaded devices and an external interface. The controlling device is called the master device. |
| SRAM                        | An acronym for static random access memory. A memory device where you can store and retrieve data at a high rate of speed. The term static is used because, after a value is loaded into an SRAM cell, it remains unchanged until it is explicitly altered or until power is removed from the device.                                               |
| SROM                        | An acronym for supervisory read only memory. The SROM holds code that is used to boot the device, calibrate circuitry, and perform Flash operations. The functions of the SROM may be accessed in normal user code, operating from Flash.                                                                                                           |
| stop bit                    | A signal following a character or block that prepares the receiving device to receive the next character or block.                                                                                                                                                                                                                                  |
| synchronous                 | <ol style="list-style-type: none"> <li>1. A signal whose data is not acknowledged or acted upon until the next active edge of a clock signal.</li> <li>2. A system whose operation is synchronized by a clock signal.</li> </ol>                                                                                                                    |
| tri-state                   | A function whose output can adopt three states: 0, 1, and Z (high-impedance). The function does not drive any value in the Z state and, in many respects, may be considered to be disconnected from the rest of the circuit, allowing another output to drive the same net.                                                                         |
| UART                        | A UART or universal asynchronous receiver-transmitter translates between parallel bits of data and serial bits.                                                                                                                                                                                                                                     |
| user modules                | Pre-build, pre-tested hardware/firmware peripheral functions that take care of managing and configuring the lower level Analog and Digital PSoC Blocks. User Modules also provide high level <b>API (Application Programming Interface)</b> for the peripheral function.                                                                            |
| user space                  | The bank 0 space of the register map. The registers in this bank are more likely to be modified during normal program execution and not just during initialization. Registers in bank 1 are most likely to be modified only during the initialization phase of the program.                                                                         |

## **Glossary** *(continued)*

|                |                                                                                                                     |
|----------------|---------------------------------------------------------------------------------------------------------------------|
| $V_{DD}$       | A name for a power net meaning "voltage drain." The most positive power supply signal. Usually 5 V or 3.3 V.        |
| $V_{SS}$       | A name for a power net meaning "voltage source." The most negative power supply signal.                             |
| watchdog timer | A timer that must be serviced periodically. If it is not serviced, the CPU resets after a specified period of time. |

## Errata

### CY8C20110

This section discusses the changes between the firmware revisions  $\times 15$  and  $\times 1B$  in CY8C20110 devices. All shipments of samples and production parts with firmware version  $\times 1B$  will encounter the following changes from the previous ( $\times 15$ ) version of the firmware. Cypress inventory has been rotated to the  $\times 1B$  firmware by WW35, and all distributor inventory will be rotated by WW42 of 2008.

Contact your local Cypress Sales Representative if you have questions.

#### Part Numbers Affected

| Part Number | Package Type | Operating Range         |
|-------------|--------------|-------------------------|
| CY8C20110   | All packages | Commercial / Industrial |

#### Product Status

The CY8C20110 CapSense Express device has been qualified and is available in production quantities. From now on, customers are requested to use production release of CY8C20110 with  $\times 1B$  firmware version.

#### CapSense Express CY8C20110 Errata Summary

The following table defines the errata applicable to CY8C20110 device.

**Table 19. CapSense Express CY8C20110 Errata Summary**

| Item | Issues/Changes | Description                                                                                                                          | Fix Status                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
|------|----------------|--------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1    | I2C ACK        | Reduction of I2C ACK timing response by the CapSense Express slave.<br>Time in Normal Operating Mode.                                | Worst case Ack timing of 140 $\mu$ s for all critical registers (Input, Output, CapSense Global Parameters, CapSense Buttons/Slider Read-back Values). For more information on critical registers I2C timings, refer to application note <a href="#">AN44208</a> "CapSense Express - I2C Communication Timing Analysis".                                                                                                                                                        |
| 2    | I2C ACK        | Reduction of I2C ACK timing response by the CapSense Express slave.<br>Time when executing commands to store configuration in Flash. | The CY8C20110 device ACK to host within 100 $\mu$ s, but is not accessible for any other operation until configuration is successfully stored into flash memory and the device is ready to execute the next command. For more information on I2C timings, refer to application note <a href="#">AN44208</a> "CapSense Express - I2C Communication Timing Analysis".                                                                                                             |
| 3    | Data Filtering | Addition of two on-chip filtering algorithms for improved CapSense performance and better noise immunity.                            | <b>Averaging Filter</b><br>This smoothens the raw count data, and results in better noise immunity and performance. The filter can average 2, 4, 8, or 16 samples.<br><b>Drop the Sample Filter</b><br>This discards any acquired CapSense sample if an I <sup>2</sup> C communication occurs after the scan process has already started.<br>For more information on filtering, refer to application note <a href="#">AN48430</a> "CapSense Express - Noise Filtering Methods". |
| 4    | PWM Control    | The PWM output functionality has been added on GPIOs to support LED brightness control.                                              | Four configuration registers (18h, 19h, 1Ah, 1Bh) are added to set PWM duty cycles and modes. This set of registers provides options that support 15 duty cycles on PWM output and 4 modes of PWM operations, which are defined as Normal, Single Pulse, Delayed Transition, and Toggle Flip-Flop. For more information on duty cycles and PWM mode settings, refer to application note <a href="#">AN47716</a> "Configuring PWM for LED Intensity Control".                    |

**Table 19. CapSense Express CY8C20110 Errata Summary (continued)**

| Item | Issues/Changes                   | Description                                                                                                                                           | Fix Status                                                                                                                                                                                                                                  |
|------|----------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 5    | Save to Flash                    | Save to flash command fails when the sleep interval is set to 512 or 64 Hz.                                                                           | No fix will be provided. When using save to flash follow these steps:<br>1. Write configuration data to registers with sleep interval set to 8 or 1 Hz<br>2. Save the settings to flash<br>3. Change the sleep interval settings per design |
| 6    | False Triggering During Power-Up | If a finger is on the sensor during power-up the sensor triggers and the baseline gets stuck. This only happens when the Averaging Filter is enabled. | No fix will be provided. Disable the Averaging Filter if your design requires a finger on the sensor during power-up.                                                                                                                       |

**CY8C20140/142/160/180/1A0**

This section describes the changes between the firmware revisions  $\times 15$  and  $\times 1B$  in CapSense Express devices (CY8C20140/142/160/180/1A0). All shipments of samples and production parts with firmware version  $\times 1B$  will encounter the following changes from the previous ( $\times 15$ ) version of the firmware. Cypress inventory has been rotated to the  $\times 1B$  firmware by WW35, and all distributor inventory will be rotated by WW42 of 2008.

Contact your local Cypress Sales Representative if you have questions.

*Part Numbers Affected*

| Part Number | Package Type | Operating Range       |
|-------------|--------------|-----------------------|
| CY8C20140   | All packages | Commercial/Industrial |
| CY8C20142   | All packages | Commercial/Industrial |
| CY8C20160   | All packages | Commercial/Industrial |
| CY8C20180   | All packages | Commercial/Industrial |
| CY8C201A0   | All packages | Commercial/Industrial |

*Product Status*

The CY8C20140/142/160/180/1A0 CapSense Express devices have been qualified and are available in production quantities. From now on, customers are requested to use the production release of CapSense Express device with  $\times 1B$  firmware version.

*CapSense Express CY8C20140/142/160/180/1A0 Errata Summary*

The following table defines the errata applicable to Cypress CapSense Express devices.

**Table 20. CapSense Express CY8C20140/142/160/180/1A0 Errata Summary**

| Item | Issues  | Description                                                                                                                           | Fix Status                                                                                                                                                                                                                                                                                                                                                                                                                      |
|------|---------|---------------------------------------------------------------------------------------------------------------------------------------|---------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 1    | I2C ACK | Reduction of I2C ACK timing response by the CapSense Express slave.<br>(Time in Normal Operating Mode)                                | Worst case Ack timing of 140 $\mu$ s for all critical registers (Input, Output, CapSense Global Parameters, and CapSense Buttons and Slider Read-back Values). For more information on critical register I2C timings, refer to application note <a href="#">AN44208</a> "CapSense Express - I2C Communication Timing Analysis".                                                                                                 |
| 2    | I2C ACK | Reduction of I2C ACK timing response by the CapSense Express slave.<br>(Time when executing commands to store configuration in Flash) | The CapSense Express device ACK to host within 100 $\mu$ s but is not accessible for any other operation until the configuration is successfully stored into flash memory, and the CapSense Express device is ready to execute the next command. For more information on I2C timings to store configuration in Flash, refer to application note <a href="#">AN44208</a> "CapSense Express - I2C Communication Timing Analysis". |

**Table 20. CapSense Express CY8C20140/142/160/180/1A0 Errata Summary (continued)**

| Item | Issues                           | Description                                                                                                                                           | Fix Status                                                                                                                                                                                                                                                                                                                                                                                                                                                                                   |
|------|----------------------------------|-------------------------------------------------------------------------------------------------------------------------------------------------------|----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| 3    | Data Filtering                   | Addition of two on-chip filtering algorithms for improved CapSense performance and better noise immunity.                                             | <p><b>Averaging Filter</b><br/>This smoothens the raw count data, and results in better noise immunity and performance. The filter can average 2, 4, 8, or 16 samples.</p> <p><b>Drop the Sample Filter</b><br/>This discards any acquired CapSense sample if an I<sup>2</sup>C communication occurs after the scan process has already started.</p> <p>For more information on filtering, refer to application note <a href="#">AN48430</a> "CapSense Express-Noise Filtering Methods".</p> |
| 4    | Save to Flash                    | Save to flash command fails when the sleep interval is set to 512 or 64 Hz.                                                                           | <p>No fix will be provided. When using save to flash follow these steps:</p> <ol style="list-style-type: none"> <li>1. Write configuration data to registers with sleep interval set to 8 or 1 Hz</li> <li>2. Save the settings to flash</li> <li>3. Change the sleep interval settings per design</li> </ol>                                                                                                                                                                                |
| 5    | False Triggering During Power-Up | If a finger is on the sensor during power-up the sensor triggers and the baseline gets stuck. This only happens when the Averaging Filter is enabled. | No fix will be provided. Disable the Averaging Filter if your design requires a finger on the sensor during power-up.                                                                                                                                                                                                                                                                                                                                                                        |

## Document History Page

| Document Title: CY8C20110/CY8C20180/CY8C20160/CY8C20140/CY8C20142, CapSense® Express™ Button Capacitive Controllers<br>Document Number: 001-54606 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
|---------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|-----------------|-----------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                                                                                              | ECN     | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                               |
| **                                                                                                                                                | 2741726 | SLAN / FSU      | 07/21/2009      | New data sheet.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                     |
| *A                                                                                                                                                | 2821828 | SSHH / FSU      | 12/4/2009       | Added <a href="#">Contents</a> .<br>Updated <a href="#">Absolute Maximum Ratings</a> (Added F32k u, t <sub>POWERUP</sub> parameters and their details).<br>Updated <a href="#">Electrical Specifications</a> (Updated <a href="#">DC Electrical Specifications</a> (Updated <a href="#">DC Flash Write Specifications</a> (Updated Note 32))).                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| *B                                                                                                                                                | 2892629 | NJF             | 03/15/2010      | Updated <a href="#">Pin Definitions</a> (Added a Note "For information on the preferred dimensions for mounting QFN packages, see the "Application Notes for Surface Mount Assembly of Amkor's MicroLeadFrame (MLF) Packages" available at <a href="http://www.amkor.com">http://www.amkor.com</a> ." below the column).<br>Updated <a href="#">Absolute Maximum Ratings</a> (Added T <sub>BAKETEMP</sub> and T <sub>BAKETIME</sub> parameters and their details).<br>Updated <a href="#">Package Diagrams</a> (Updated <a href="#">Figure 1</a> (Changed 16-pin COL to 16-pin QFN).                                                                                                                                                                                                                |
| *C                                                                                                                                                | 3002214 | SLAN            | 07/29/2010      | Updated <a href="#">Features</a> (Changed the part number from CY8C21110 to CY8C20110).<br>Added <a href="#">Acronyms</a> and <a href="#">Units of Measure</a> .<br>Minor edits across the document.                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                                |
| *D                                                                                                                                                | 3042142 | ARVM            | 09/30/10        | Updated <a href="#">Pin Definitions</a> (Added Note 3 and referred the same Note in all GP1[1] and GP1[2] pins).<br>Updated <a href="#">Pin Definitions</a> (Added Note 6 and referred the same Note in all GP1[1] and GP1[2] pins).<br>Updated <a href="#">Pin Definitions</a> (Added Note 7 and referred the same Note in all GP1[1] and GP1[2] pins).<br>Updated <a href="#">Absolute Maximum Ratings</a> (Removed F32k u, t <sub>POWERUP</sub> parameters and their details).<br>Updated <a href="#">Electrical Specifications</a> (Updated <a href="#">AC Electrical Specifications</a> (Added <a href="#">AC Chip-Level Specifications</a> section)).<br>Updated <a href="#">Typical Circuits</a> (Updated <a href="#">Figure 4</a> (Replaced with updated one)).<br>Updated in new template. |
| *E                                                                                                                                                | 3085081 | NJF             | 11/12/10        | Updated <a href="#">Electrical Specifications</a> (Updated <a href="#">DC Electrical Specifications</a> (Updated <a href="#">DC GPIO Specifications</a> (Removed sub-section "2.7-V DC Spec for I <sup>2</sup> C Line with 1.8 V External Pull-up"), added <a href="#">DC I2C Specifications</a> )), updated <a href="#">AC Electrical Specifications</a> (Updated <a href="#">AC I<sup>2</sup>C Specifications</a> (Updated <a href="#">Figure 12</a> (No specific changed were made to I2C Timing Diagram. Updated for clearer understanding.)))).<br>Updated <a href="#">Solder Reflow Specifications</a> (Updated <a href="#">Table 16</a> ).<br>Added <a href="#">Reference Documents</a> and <a href="#">Glossary</a> .<br>Updated in new template.                                           |
| *F                                                                                                                                                | 3276234 | ARVM            | 06/07/11        | Updated <a href="#">Layout Guidelines and Best Practices</a> (Updated <a href="#">Table 2</a> (Removed "Overlay thickness-buttons" category), added the following statement after <a href="#">Table 2</a> –<br>"The Recommended maximum overlay thickness is 5 mm (with external CS <sub>Int</sub> )/ 2 mm (without external CS <sub>Int</sub> ). For more details refer to the section "The Integrating Capacitor (Cint)" in <a href="#">AN53490</a> .<br><b>Note</b> Some device packages does not have CS <sub>Int</sub> pin and external capacitor cannot be connected.").<br>Updated <a href="#">CapSense Constraints</a> (Removed the parameter "Overlay thickness").<br>Updated <a href="#">Solder Reflow Specifications</a> (Updated <a href="#">Table 16</a> ).                            |

**Document History Page** *(continued)*

| Document Title: CY8C20110/CY8C20180/CY8C20160/CY8C20140/CY8C20142, CapSense® Express™ Button Capacitive Controllers<br>Document Number: 001-54606 |         |                 |                 |                                                                                                                                                                                                                                                                                                                                                                                                                                                                                            |
|---------------------------------------------------------------------------------------------------------------------------------------------------|---------|-----------------|-----------------|--------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------------|
| Rev.                                                                                                                                              | ECN     | Orig. of Change | Submission Date | Description of Change                                                                                                                                                                                                                                                                                                                                                                                                                                                                      |
| *G                                                                                                                                                | 3631370 | VAIR / SLAN     | 05/31/2012      | Updated <a href="#">Pin Definitions</a> (Updated description of XRES pin).<br>Updated <a href="#">Pin Definitions</a> (Updated description of XRES pin).<br>Updated <a href="#">Typical Circuits</a> (Updated <a href="#">Figure 6</a> (Added Note 9 and referred the same Note in <a href="#">Figure 6</a> )).<br>Updated <a href="#">Package Diagrams</a> (spec 001-09116 (Changed revision from *E to *F), spec 51-85068 (Changed revision from *C to *D)).<br>Updated in new template. |
| *H                                                                                                                                                | 3837914 | SLAN            | 12/11/2012      | Updated <a href="#">Device Operation Modes</a> (Updated <a href="#">Periodic Sleep Mode</a> (Updated description)).<br>Updated <a href="#">Package Diagrams</a> (spec 001-09116 (Changed revision from *F to *G), spec 51-85068 (Changed revision from *D to *E)).                                                                                                                                                                                                                         |
| *I                                                                                                                                                | 3992042 | SLAN            | 05/06/2013      | Updated <a href="#">Package Diagrams</a> :<br>spec 001-09116 – Changed revision from *G to *H.<br>spec 51-85066 – Changed revision from *E to *F.<br>Added <a href="#">Errata</a> .<br>Added <a href="#">CY8C20140/142/160/180/1A0</a> .                                                                                                                                                                                                                                                   |
| *J                                                                                                                                                | 4033835 | DCHE            | 06/19/2013      | Added Errata Footnotes.<br>Updated in new template.                                                                                                                                                                                                                                                                                                                                                                                                                                        |
| *K                                                                                                                                                | 4489897 | PRIA            | 09/01/2014      | Updated duration for which the device is not accessible after ACK timing for the "Set Setup mode of operation" command."<br>Added notes 17, 27, and 29.                                                                                                                                                                                                                                                                                                                                    |

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